lenovo

Lenovo G700/G710

Hardware Maintenance Manual

Note:

Before using this information and the product it supports, be sure to read the general information under "Notices" on page 83.

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About this manual

This manual contains service and reference information for the following Lenovo product:

Lenovo G700/G710

Use this manual to troubleshoot problems.

The manual is divided into the following sections:

- The common sections provide general information, guidelines, and safety information required for servicing computers.
- The product-specific section includes service, reference, and product-specific parts information.

Important:

This manual is intended only for trained servicers who are familiar with Lenovo products. Use this manual to troubleshoot problems effectively. Before servicing a Lenovo product, make sure to read all the information under "Safety information" on page 1 and "Important service information" on page 16.

Safety information

This chapter presents the following safety information that you need to get familiar with before you service a Lenovo computer:

- see "General safety" on page 2
- see "Electrical safety" on page 3
- see "Safety inspection guide" on page 5
- see "Handling devices that are sensitive to electrostatic discharge" on page 6
- see "Grounding requirements" on page 6
- see "Safety notices: multilingual translations" on page 7
- see "Laser compliance statement" on page 14

General safety

Follow these rules below to ensure general safety:

- Observe a good housekeeping in the area where the machines are put during and after the maintenance.
- When lifting any heavy object:
 - 1. Make sure that you can stand safely without slipping.
 - 2. Distribute the weight of the object equally between your feet.
 - Use a slow lifting force. Never move suddenly or twist when you attempt to lift it.
 - Lift it by standing or pushing up with your leg muscles; this action could avoid the strain from the muscles in your back. Do not attempt to lift any object that weighs more than 16 kg (35 lb) or that you think is too heavy for you.
- Do not perform any action that causes hazards to the customer, or that makes the machine unsafe.
- Before you start the machine, make sure that other service representatives and the customer are not in a hazardous position.
- Please remove covers and other parts in a safe place, away from all
 personnel, while you are servicing the machine.
- Keep your toolcase away from walk areas so that other people will not trip it over
- Do not wear loose clothing that can be trapped in the moving parts of the machine. Make sure that your sleeves are fastened or rolled up above your elbows. If your hair is long, fasten it.
- Insert the ends of your necktie or scarf inside clothing or fasten it with the nonconductive clip, about 8 centimeters (3 inches) from the end.
- Do not wear jewelry, chains, metal-frame eyeglasses, or metal fasteners for your clothing.

Attention: Metal objects are good electrical conductors.

- Wear safety glasses when you are hammering, drilling, soldering, cutting
 wire, attaching springs, using solvents, or working in any other conditions
 that may be hazardous to your eyes.
- After service, reinstall all safety shields, guards, labels, and ground wires.
 Replace any safety device that is worn or defective.
- Reinstall all covers correctly before returning the machine to the customer.
- Fan louvers on the machine help to prevent the overheating of internal components. Do not obstruct fan louvers or cover them with labels or stickers.

Electrical safety

Observe the following rules when working on electrical equipments.

Important:

Use only approved tools and test equipments. Some hand tools have handles covered with a soft material that does not insulate you when working with live electrical currents.

Many customers have rubber floor mats near their machines that contain small conductive fibers to decrease electrostatic discharges. Do not use such kind of mat to protect yourself from electrical shock.

- Find the room emergency power-off (EPO) switch, disconnecting switch, or
 electrical outlet. If an electrical accident occurs, you can then operate the
 switch or unplug the power cord quickly.
- Do not work alone under hazardous conditions or near the equipment that has hazardous voltages.
- Disconnect all power before:
 - Performing a mechanical inspection
 - Working near power supplies
 - Removing or installing main units
- Before you start to work on the machine, unplug the power cord. If you
 cannot unplug it, ask the customer to power-off the wall box that supplies
 power to the machine, and to lock the wall box in the off position.
- If you need to work on a machine that has exposed electrical circuits, observe the following precautions:
 - Ensure that another person, familiar with the power-off controls, is near you.

Attention: Another person must be there to switch off the power, if necessary.

- Use only one hand when working with powered-on electrical equipment; keep the other hand in your pocket or behind your back.
 - **Attention:** An electrical shock can occur only when there is a complete circuit. By observing the above rule, you may prevent a current from passing through your body.
- When using testers, set the controls correctly and use the approved probe leads and accessories for that tester.
- Stand on suitable rubber mats (obtained locally, if necessary) to insulate you from grounds such as metal floor strips and machine frames.

Observe the special safety precautions when you work with very high voltages; instructions for these precautions are in the safety sections of maintenance information. Be extremely careful when you measure the high voltages.

- Regularly inspect and maintain your electrical hand tools for safe operational condition.
- Do not use worn or broken tools and testers.
- Never assume that power has been disconnected from a circuit. First, check it to make sure that it has been powered off.

- Always look carefully for possible hazards in your work area. Examples of these hazards are moist floors, nongrounded power extension cables, power surges, and missing safety grounds.
- Do not touch live electrical circuits with the reflective surface of a plastic dental mirror. The surface is conductive; such touching can cause personal injury and machine damage.
- Do not service the following parts with the power on when they are removed from their normal operating places in a machine:
 - Power supply units
 - Pumps
 - Blowers and fans
 - Motor generators

and similar units. (This practice ensures correct grounding of the units.)

- If an electrical accident occurs:
 - Use caution: do not become a victim yourself.
 - Switch off the power.
 - Send the victim to get medical aid.

Safety inspection guide

The purpose of this inspection guide is to assist you in identifying potential unsafe conditions. As each machine was designed and built, required safety items were installed to protect users and service personnel from injury. This guide addresses only those items. You should use good judgment to identify potential safety hazards due to attachment of non-Lenovo features or options not covered by this inspection guide.

If any unsafe conditions are present, you must determine how serious the apparent hazard could be and whether you can continue without first correcting the problem.

Consider these conditions and the safety hazards they present:

- Electrical hazards, especially primary power (primary voltage on the frame can cause serious or fatal electrical shock)
- Explosive hazards, such as a damaged CRT face or a bulging capacitor
- · Mechanical hazards, such as loose or missing hardware

To determine whether there are any potential unsafe conditions, use the following checklist at the beginning of every service task. Begin the checks with the power off, and the power cord disconnected.

Checklist:

- 1. Check exterior covers for damage (loose, broken, or sharp edges).
- Turn off the computer. Disconnect the power cord.
- 3. Check the power cord for:
 - a. A third-wire ground connector in good condition. Use a meter to measure third-wire ground continuity for 0.1 ohm or less between the external ground pin and the frame ground.
 - b. The power cord should be the type specified in the parts list.
 - Insulation must not be frayed or worn.
- 4. Check for cracked or bulging batteries.
- Remove the cover.
- Check for any obvious non-Lenovo alterations. Use good judgment as to the safety of any non-Lenovo alterations.
- Check inside the unit for any obvious unsafe conditions, such as metal filings, contamination, water or other liquids, or signs of fire or smoke damage.
- 8. Check for worn, frayed, or pinched cables.
- Check that the power-supply cover fasteners (screws or rivets) have not been removed or tampered with.

Handling devices that are sensitive to electrostatic discharge

Any computer part containing transistors or integrated circuits (ICs) should be considered sensitive to electrostatic discharge (ESD). ESD damage can occur when there is a difference in charge between objects. Protect against ESD damage by equalizing the charge so that the machine, the part, the work mat, and the person handling the part are all at the same charge.

Notes:

- Use product-specific ESD procedures when they exceed the requirements noted here.
- Make sure that the ESD protective devices you use have been certified (ISO 9000) as fully effective.

When handling ESD-sensitive parts:

- Keep the parts in protective packages until they are inserted into the product.
- Avoid contact with other people.
- Wear a grounded wrist strap against your skin to eliminate static on your body.
- Prevent the part from touching your clothing. Most clothing is insulative and retains a charge even when you are wearing a wrist strap.
- Use the black side of a grounded work mat to provide a static-free work surface. The mat is especially useful when handling ESD-sensitive devices.
- Select a grounding system, such as those listed below, to provide protection that meets the specific service requirement.

Notes:

The use of a grounding system to guard against ESD damage is desirable but not necessary.

- Attach the ESD ground clip to any frame ground, ground braid, or greenwire ground.
- When working on a double-insulated or battery-operated system, use an ESD common ground or reference point. You can use coax or connectoroutside shells on these systems.
- Use the round ground prong of the ac plug on ac-operated computers.

Grounding requirements

Electrical grounding of the computer is required for operator safety and correct system function. Proper grounding of the electrical outlet can be verified by a certified electrician.

Safety notices: multilingual translations

The safety notices in this section are provided in English, French, German, Hebrew, Italian, Japanese, and Spanish.

Safety notice 1

Before the computer is powered on after FRU replacement, make sure all screws, springs, and other small parts are in place and are not left loose inside the computer. Verify this by shaking the computer and listening for rattling sounds. Metallic parts or metal flakes can cause electrical shorts.

Avant de remettre l'ordinateur sous tension après remplacement d'une unité en clientèle, vérifiez que tous les ressorts, vis et autres pièces sont bien en place et bien fixées. Pour ce faire, secouez l'unité et assurez-vous qu'aucun bruit suspect ne se produit. Des pièces métalliques ou des copeaux de métal pourraient causer un court-circuit.

Bevor nach einem FRU-Austausch der Computer wieder angeschlossen wird, muß sichergestellt werden, daß keine Schrauben, Federn oder andere Kleinteile fehlen oder im Gehäuse vergessen wurden. Der Computer muß geschüttelt und auf Klappergeräusche geprüft werden. Metallteile odersplitter können Kurzschlüsse erzeugen.

לפני הפעלת המחשב לאחר החלפה TRU יש לוודא שכל הברגים, הקפיצים, וחלקים קטנים אחרים נמצאים במקונים ואינים חופטיים לזוו בתוך המחשב. כדי לוודא זאת, יש לטלטל את המחשב ולהקשיב לגילוי קולות שקשוק, חלקי או שבני מורכת עלולים לנודם לקצרים חשמליים. חלקי או שבני מורכת עלולים לנוד

Prima di accendere l'elaboratore dopo che é stata effettuata la sostituzione di una FRU, accertarsi che tutte le viti, le molle e tutte le altri parti di piccole dimensioni siano nella corretta posizione e non siano sparse all'interno dell'elaboratore. Verificare ciò scuotendo l'elaboratore e prestando attenzione ad eventuali rumori; eventuali parti o pezzetti metallici possono provocare cortocircuiti pericolosi.

FRUの交換後、コンピュータの電源を入れる前に、ねじ、バネ、その他の小さな部品がすべて正しい位置にあり、またコンピュータの内部で緩んでいないことを確認してください。これを確認するには、コンピュータを振って、カチャカチャと音がしないか確かめま

これを確認するには、コンピュータを振って、カナヤカナヤと音がしないか確かめます。金属部品や金属破片はショートの原因になることがあります。

Antes de encender el sistema despues de sustituir una FRU, compruebe que todos los tornillos, muelles y demás piezas pequeñas se encuentran en su sitio y no se encuentran sueltas dentro del sistema. Compruébelo agitando el sistema y escuchando los posibles ruidos que provocarían. Las piezas metálicas pueden causar cortocircuitos eléctricos.

⚠ DANGER

Some standby batteries contain a small amount of nickel and cadmium. Do not disassemble a standby battery, recharge it, throw it into fire or water, or short-circuit it. Dispose of the battery as required by local ordinances or regulations. Use only the battery in the appropriate parts listing. Use of an incorrect battery can result in ignition or explosion of the battery.

Certaines batteries de secours contiennent du nickel et du cadmium. Ne les démontez pas, ne les rechargez pas, ne les exposez ni au feu ni à l'eau. Ne les mettez pas en court-circuit. Pour les mettre au rebut, conformez-vous à la réglementation en vigueur. Lorsque vous remplacez la pile de sauvegarde ou celle de l'horloge temps réel, veillez à n'utiliser que les modèles cités dans la liste de pièces détachées adéquate. Une batterie ou une pile inappropriée risque de prendre feu ou d'exploser.

Die Bereitschaftsbatterie, die sich unter dem Diskettenlaufwerk befindet, kann geringe Mengen Nickel und Cadmium enthalten. Sie darf nicht zerlegt, wiederaufgeladen, kurzgeschlossen, oder Feuer oder Wasser ausgesetzt werden. Bei der Entsorgung die örtlichen Bestimmungen für Sondermüll beachten. Beim Ersetzen der Bereitschafts-oder Systembatterie nur Batterien des Typs verwenden, der in der Ersatzteilliste aufgeführt ist. Der Einsatz falscher Batterien kann zu Entzündung oder Explosion führen.

סוללות התתנה מסוימות מכילות כמות קטנה של ניקל התתנה. אין לבקר סוללת המתנה, לטעון אותה מחדש, להשליך אותה לאש או לטעון אותה מחדש, להשליך אותה לאש או למים או לקצר אותה. יש לסלק את הסוללה בכדרש על ידי התקנות והחוקים המקומיים. יש להשתמש רק בסוללה המומיעה ברשימת התלקים המתאימה, עולל להשתמש היש בסוללה לא מתאימה עולל לגרום לאתרה או התמצועות של חסולה.

Alcune batterie di riserva contengono una piccola quantità di nichel e cadmio. Non smontarle, ricaricarle, gettarle nel fuoco o nell'acqua né cortocircuitarle. Smaltirle secondo la normativa in vigore (DPR 915/82, successive disposizioni e disposizioni locali). Quando si sostituisce la batteria dell'RTC (real time clock) o la batteria di supporto, utilizzare soltanto i tipi inseriti nell'appropriato Catalogo parti. L'impiego di una batteria non adatta potrebbe determinare l'incendio o l'esplosione della batteria stessa.

予備バッテリーの中には少量のニッケルとカドミウムが含まれているものがあります。したがって、予備バッテリーの分解、再充電、火または水の中への投棄、またはショートさせることは決して行わないでください。バッテリーを廃棄する場合は地方自治体の条例に従ってください。適切なパーツ・リストにあるバッテリーだけを使用してください。誤ったバッテリーを使用すると、バッテリーが発火したり、爆発したりすることがあります。

Algunas baterías de reserva contienen una pequeña cantidad de níquel y cadmio. No las desmonte, ni recargue, ni las eche al fuego o al agua ni las cortocircuite. Deséchelas tal como dispone la normativa local. Utilice sólo baterías que se encuentren en la lista de piezas. La utilización de una batería no apropiada puede provocar la ignición o explosión de la misma.

⚠ DANGER

The battery pack contains small amounts of nickel. Do not disassemble it, throw it into fire or water, or short-circuit it. Dispose of the battery pack as required by local ordinances or regulations. Use only the battery in the appropriate parts listing when replacing the battery pack. Use of an incorrect battery can result in ignition or explosion of the battery.

La batterie contient du nickel. Ne la démontez pas, ne l'exposez ni au feu ni à l'eau. Ne la mettez pas en court-circuit. Pour la mettre au rebut, conformez-vous à la réglementation en vigueur. Lorsque vous remplacez la batterie, veillez à n'utiliser que les modèles cités dans la liste de pièces détachées adéquate. En effet, une batterie inappropriée risque de prendre feu ou d'exploser.

Akkus enthalten geringe Mengen von Nickel. Sie dürfen nicht zerlegt, wiederaufgeladen, kurzgeschlossen, oder Feuer oder Wasser ausgesetzt werden. Bei der Entsorgung die örtlichen Bestimmungen für Sondermüll beachten. Beim Ersetzen der Batterie nur Batterien des Typs verwenden, der in der Ersatzteilliste aufgeführt ist. Der Einsatz falscher Batterien kann zu Entzündung oder Explosion führen.

מארו הסוללה מכיל כמות קטנה של ניקל
קדמניום. אין לפרק את מארו הסוללה, להשליך
אותו לאש או למים או לקצר אותו. יש לסלק את
מארו הסוללה הסוללה כנדרש על ידי התפנות
והחוקים המקומיים. יש להשתמש רק בסוללה
המופעה ברשימות החלקים המתאימה בזמן החלפת
מארו הסוללה. שימוש בסוללה לא מתאימה עלול
היותו לאחרה או החמוש בסוללה לא מתאימה עלול
היותו לאחרה או החמוציות של החלפת

La batteria contiene piccole quantità di nichel. Non smontarla, gettarla nel fuoco o nell'acqua né cortocircuitarla. Smaltirla secondo la normativa in vigore (DPR 915/82, successive disposizioni e disposizioni locali). Quando si sostituisce la batteria, utilizzare soltanto i tipi inseriti nell'appropriato Catalogo parti. L'impiego di una batteria non adatta potrebbe determinare l'incendio o l'esplosione della batteria stessa.

バッテリー・パックには少量のニッケルが含まれています。バッテリー・パックを分解したり、火または水の中に投げ込んだり、ショートさせないでください。バッテリー・パックの廃棄にあたっては、地方自治体の条例または規則に従ってください。バッテリー・バックを交換するときは、適切ペーツ・リストにあるバッテリーだけを使用してください。誤ったバッテリーを使用すると、バッテリーが発火したり、爆発したりすることがあります。

Las baterías contienen pequeñas cantidades de níquel. No las desmonte, ni recargue, ni las eche al fuego o al agua ni las cortocircuite. Deséchelas tal como dispone la normativa local. Utilice sólo baterías que se encuentren en la lista de piezas al sustituir la batería. La utilización de una batería no apropiada puede provocar la ignición o explosión de la misma.

⚠ DANGER

The lithium battery can cause a fire, an explosion, or a severe burn. Do not recharge it, remove its polarized connector, disassemble it, heat it above 100° C (212° F), incinerate it, or expose its cell contents to water. Dispose of the battery as required by local ordinances or regulations. Use only the battery in the appropriate parts listing. Use of an incorrect battery can result in ignition or explosion of the battery.

La pile de sauvegarde contient du lithium. Elle présente des risques d'incendie, d'explosion ou de brûlures graves. Ne la rechargez pas, ne retirez pas son connecteur polarisé et ne la démontez pas. Ne l'exposez pas à une temperature supérieure à 100° C, ne la faites pas brûler et n'en exposez pas le contenu à l'eau. Mettez la pile au rebut conformément à la réglementation en vigueur. Une pile inappropriée risque de prendre feu ou d'exploser.

Die Systembatterie ist eine Lithiumbatterie. Sie kann sich entzünden, explodieren oder schwere Verbrennungen hervorrufen. Batterien dieses Typs dürfen nicht aufgeladen, zerlegt, über 100 C erhitzt oder verbrannt werden. Auch darf ihr Inhalt nicht mit Wasser in Verbindung gebracht oder der zur richtigen Polung angebrachte Verbindungsstecker entfernt werden. Bei der Entsorgung die örtlichen Bestimmungen für Sondermüll beachten. Beim Ersetzen der Batterie nur Batterien des Typs verwenden, der in der Ersatzteilliste aufgeführt ist. Der Einsatz falscher Batterien kann zu Entzündung oder Explosion führen.

סוללות הליותים עלולה לגרום לשריפה, להתפוצצות או לכולות הליותים עשות. או לשלק את המקוטב לשלק את המקוטב שלה, לפרק אותה או להמט אותה לטמפרטורה המקוטב שלה, לפרק אותה או להמט אותה לטמפרטורה העולה על 200 מעלות צליוט. אין לשרוף את הסוללה ואין החשוף את תוכן התא למים. איש לשלק את הטוללה כגדות בתקנות ובחוקים המקומיים. יש להשתמש רק בסוללה המושים ברשימות החלקים המתאימים. שימוש בסוללה המופיאם ארת עלול לגרוט לסכנת שריפה או התפתצוצות.

La batteria di supporto e una batteria al litio e puo incendiarsi, esplodere o procurare gravi ustioni. Evitare di ricaricarla, smontarne il connettore polarizzato, smontarla, riscaldarla ad una temperatura superiore ai 100 gradi centigradi, incendiarla o gettarla in acqua. Smaltirla secondo la normativa in vigore (DPR 915/82, successive disposizioni e disposizioni locali). L'impiego di una batteria non adatta potrebbe determinare l'incendio o l'esplosione della batteria stessa.

リチウム・バッテリーは、火災、爆発、または重症のやけどを引き起こすことがあります。バックアップ・バッテリーの充電、その極性コネクターの取り外し、バッテリー本体の分解、100°C(212°F)以上への加熱、焼却、電池の中身を水に浸すことはしないでください。バッテリーを廃棄する場合は地方自治体の条例に従ってください。適切なパーツ・リストにあるバッテリーだけを使用してください。関ったバッテリーを使用すると、バッテリーが発火したり、爆発したりすることがあります。

La batería de repuesto es una batería de litio y puede provocar incendios, explosiones o quemaduras graves. No la recargue, ni quite el conector polarizado, ni la desmonte, ni caliente por encima de los 100°C (212°F), ni la incinere ni exponga el contenido de sus celdas al agua. Deséchela tal como dispone la normativa local.

If the LCD breaks and the fluid from inside the LCD gets into your eyes or on your hands, immediately wash the affected areas with water at least for 15 minutes. Seek medical care if any symptoms caused by the fluid are present after washing.

Si le panneau d'affichage à cristaux liquides se brise et que vous recevez dans les yeux ou sur les mains une partie du fluide, rincez-les abondamment pendant au moins quinze minutes. Consultez un médecin si des symptômes persistent après le lavage.

Die Leuchtstoffröhre im LCD-Bildschirm enthält Quecksilber. Bei der Entsorgung die örtlichen Bestimmungen für Sondermüll beachten. Der LCD-Bildschirm besteht aus Glas und kann zerbrechen, wenn er unsachgemäß behandelt wird oder der Computer auf den Boden fällt. Wenn der Bildschirm beschädigt ist und die darin befindliche Flüssigkeit in Kontakt mit Haut und Augen gerät, sollten die betroffenen Stellen mindestens 15 Minuten mit Wasser abgespült und bei Beschwerden anschließend ein Arzt aufgesucht werden.

אם מסך הגביש הנוזלי (LCD) נשבר והנוזל מתוך המסך בא במגע עם עניכם או ידיכם, שטפו את האזורים הנגועים מיד במים במשך 15 דקות לפחות. פנו לקבלת עזרה רפואית אם תסמינים הנובעים מתמגע עם הנוזל נמשכים לאחר השטיפה.

Nel caso che caso l'LCD si dovesse rompere ed il liquido in esso contenuto entrasse in contatto con gli occhi o le mani, lavare immediatamente le parti interessate con acqua corrente per almeno 15 minuti; poi consultare un medico se i sintomi dovessero permanere.

LCD が破損し、 LCD の中の液体が目に入ったり、手に触れたりした場合は、液体が触れた部分を少なくとも 15 分間洗い流してください。洗い流した後に、液体によって何らかの症状が現れた場合は、医師の治療を受けてください。

Si la LCD se rompe y el fluido de su interior entra en contacto con sus ojos o sus manos, lave inmediatamente las áreas afectadas con agua durante 15 minutos como mínimo. Obtenga atención medica si se presenta algún

⚠ DANGER

To avoid shock, do not remove the plastic cover that protects the lower part of the inverter card.

Afin d'éviter tout risque de choc électrique, ne retirez pas le cache en plastique protégeant la partie inférieure de la carte d'alimentation.

Aus Sicherheitsgründen die Kunststoffabdeckung, die den unteren Teil der Spannungswandlerplatine umgibt, nicht entfernen.

כדי למנוע התחשמלות, אין להסיר את מכסה הפלסטיק המגן על חלקו התחתון של הכרטיס ההפוך.

Per evitare scosse elettriche, non rimuovere la copertura in plastica che avvolge la parte inferiore della scheda invertitore.

感電を防ぐため、インバーター・カードの下部を保護しているプラスチック・カ バーを外さないでください。

Para evitar descargas, no quite la cubierta de plástico que rodea la parte baja de la tarjeta invertida.

Safety notice 7

⚠ DANGER

Though the main batteries have low voltage, a shorted or grounded battery can produce enough current to burn personnel or combustible materials.

Bien que le voltage des batteries principales soit peu élevé, le court-circuit ou la mise à la masse d'une batterie peut produire suffisamment de courant pour brûler des matériaux combustibles ou causer des brûlures corporelles graves.

Obwohl Hauptbatterien eine niedrige Spannung haben, können sie doch bei Kurzschluß oder Erdung genug Strom abgeben, um brennbare Materialien zu entzünden oder Verletzungen bei Personen hervorzurufen.

אף שהסוללות הראשיות הן בעלות מתח נמוך, סוללה מקוצרת או מוארקת עלולה להפיק זרם מספיק לגרימת כוויות או להצתת חומרים דליקים.

Sebbene le batterie di alimentazione siano a basso voltaggio, una batteria in corto circuito o a massa può fornire corrente sufficiente da bruciare materiali combustibili o provocare ustioni ai tecnici di manutenzione.

メイン・バッテリーの電圧は低くても、ショートしたり、接地したバッテリーが、作業者にやけどを負わせたり、可燃物を燃やすだけの電流を発生させる場合があります。

Aunque las baterías principales tienen un voltaje bajo, una batería cortocircuitada o con contacto a tierra puede producir la corriente suficiente como para quemar material combustible o provocar quemaduras en el personal.

⚠ DANGER

Before removing any FRU, turn off the computer, unplug all power cords from electrical outlets, remove the battery pack, and then disconnect any interconnecting cables.

Avant de retirer une unité remplaçable en clientèle, mettez le système hors tension, débranchez tous les cordons d'alimentation des socles de prise de courant, retirez la batterie et déconnectez tous les cordons d'interface.

Die Stromzufuhr muß abgeschaltet, alle Stromkabel aus der Steckdose gezogen, der Akku entfernt und alle Verbindungskabel abgenommen sein, bevor eine FRU entfernt wird.

לפני סילוק FRU כלשהו, יש לכבות את המחשב, לנתק את כל כבלי החשמל משקעי החשמל, להוציא את מארז הסוללה, ואז לנתק כבלי חיבור אחרים אם יש כאלה.

Prima di rimuovere qualsiasi FRU, spegnere il sistema, scollegare dalle prese elettriche tutti i cavi di alimentazione, rimuovere la batteria e poi scollegare i cavi di interconnessione.

FRU を取り外す前に、 ThinkPad の電源を切って、すべての電源コードをコンセントから外してください。次に、バッテリー・パックを外し、相互接続ケーブルを外してください。

Antes de quitar una FRU, apague el sistema, desenchufe todos los cables de las tomas de corriente eléctrica, quite la batería y, a continuación, desconecte cualquier cable de conexión entre dispositivos.

Laser compliance statement

Some models of Lenovo computer are equipped from the factory with an optical storage device such as a CD-ROM drive or a DVD-ROM drive. Such devices are also sold separately as options. If one of these drives is installed, it is certified in the U.S. to conform to the requirements of the Department of Health and Human Services 21 Code of Federal Regulations (DHHS 21 CFR) Subchapter J for Class 1 laser products. Elsewhere, the drive is certified to conform to the requirements of the International Electrotechnical Commission (IEC) 825 and CENELEC EN 60 825 for Class 1 laser products.

If a CD-ROM drive, a DVD-ROM drive, or another laser device is installed, note the following:

⚠ CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein might result in hazardous radiation exposure. O uso de controles, ajustes ou desempenho de procedimentos diferentes daqueles aqui especificados pode resultar em perigosa exposição à radiação.

凡未在这里指明的任何控制用法、调整、行为,都会导致严重后果。

Pour éviter tout risque d'exposition au rayon laser, respectez les consignes de réglage et d'utilisation des commandes, ainsi que les procédures décrites.

Werden Steuer- und Einstellelemente anders als hier festgesetzt verwendet, kann gefährliche Laserstrahlung auftreten.

Az itt előírt eljárásoktól, beállításoktól és vezérlésektől eltérni a lézersugárzás veszélye miatt kockázatos!

L'utilizzo di controlli, regolazioni o l'esecuzione di procedure diverse da quelle specificate possono provocare l'esposizione a.

Использование элементов настройки и выполнение процедур иных, чем указано здесь, может привести к опасному радиационному облучению.

Použitie kontrôl, úprav alebo iných vykonaní od iných výrobcov, ako je v tomto špecifikované, mohlo by mať za následok nebezpečenstvo vystavenia sa vyžiarovaniu.

本書で指定された内容以外の、お客様による整備、調整、または手順を行った場合、レーザー光の放射の危険があります。

El uso de controles o ajustes o la ejecución de procedimientos distintos de los aquí especificados puede provocar la exposición a radiaciones peligrosas.

Opening the CD-ROM drive, the DVD-ROM drive, or any other optical storage device could result in exposure to hazardous laser radiation. There are no serviceable parts inside those drives. **Do not open**.

A CD-ROM drive, a DVD-ROM drive, or any other storage device installed may contain an embedded Class 3A or Class 3B laser diode. Note the following:

⚠ DANGER

Emits visible and invisible laser radiation when open. Do not stare into the beam, do not view directly with optical instruments, and avoid direct exposure to the beam.

Radiação por raio laser ao abrir. Não olhe fixo no feixe de luz, não olhe diretamente por meio de instrumentos óticos e evite exposição direta com o feixe de luz.

开启时会有激光发射时,请勿盯视激光光束,请勿直接查看 视觉仪器,并且避免直接接触在激光光束之中。

Rayonnement laser si carter ouvert. Évitez de fixer le faisceau, de le regarder directement avec des instruments optiques, ou de vous exposer au rayon.

Laserstrahlung bei geöffnetem Gerät. Nicht direkt oder über optische Instrumente in den Laserstrahl sehen und den Strahlungsbereich meiden.

Kinyitáskor lézersugár! Ne nézzen bele se szabad szemmel, se optikai eszközökkel. Kerülje a sugárnyalábbal való érintkezést!

Aprendo l'unità vengono emesse radiazioni laser. Non fissare il fascio, non guardarlo direttamente con strumenti ottici e evitare l'esposizione diretta al fascio.

Открывая, берегитесь лазерного излучения. Не смотрите на луч, не разглядывайте его с помощью оптических инструментов, а также избегайте прямого воздействия лазерного луча.

Keď je laserová jednotka otvorená. Vyhnite sa priamemu pohľadu a nehľadte priamo s optickými nástrojmi do ľúča a vyhnite sa priamemu vystaveniu ľúčov.

開けるとレーザー光が放射されます。光線を見つめたり、光学機械を使って直接見たりしないでください。

Radiación láser al abrir. No mire fijamente ni examine con instrumental óptico el haz de luz. Evite la exposición directa al haz.

Important service information

This chapter presents the following important service information:

- see "Strategy for replacing FRUs" on page 16
 - see "Strategy for replacing a hard disk drive" on page 17
 - see "Important notice for replacing a system board" on page 17
- see "Important information about replacing RoHS compliant FRUs" on page 18

Important:

BIOS and device driver fixes are customer-installable. The BIOS and device drivers are posted on the customer support site: http://consumersupport.lenovo.com/.

Strategy for replacing FRUs

Before replacing parts:

Make sure that all software fixes, drivers, and BIOS downloads are installed before replacing any FRUs listed in this manual.

After a system board is replaced, ensure that the latest BIOS is loaded to the system board before completing the service action.

To download software fixes, drivers, and BIOS, follow the steps below:

- 1. Go to http://consumersupport.lenovo.com/.
- Enter the serial number or select a product or use Lenovo smart downloading.
- 3. Select the BIOS/Driver/Applications and download.
- 4. Follow the directions on the screen and install the necessary software.

Use the following strategy to prevent unnecessary expense for replacing and servicing FRUs:

- If you are instructed to replace an FRU, but the replacement does not solve the problem, reinstall the original FRU before you continue.
- Some computers have both a processor board and a system board. If you are
 instructed to replace either of them, and replacing one of them does not solve
 the problem, reinstall that board, and then replace the other one.
- If an adapter or a device consists of more than one FRU, any of the FRUs may
 be the cause of the error. Before replacing the adapter or device, remove the
 FRUs one by one to see if the symptoms change. Replace only the FRU that
 changed the symptoms.

Attention: The setup configuration on the computer you are servicing may have been customized. Running Automatic Configuration may alter the settings. Note the current configuration settings (using the View Configuration option); then, when service has been completed, verify that those settings remain in effect.

Strategy for replacing a hard disk drive

Always try to run a low-level format before replacing a hard disk drive. This will cause all customer data on the hard disk to be lost. Make sure that the customer has a current backup of the data before performing this action.

Attention: The drive startup sequence in the computer you are servicing may have been changed. Be extremely careful during write operations such as copying, saving, or formatting. If you select an incorrect drive, data or programs can be overwritten.

Important notice for replacing a system board

Some components mounted on a system board are very sensitive. Improper handling can cause damage to those components, and may cause a system malfunction.

Attention: When handling a system board:

- Do not drop the system board or apply any excessive force to it.
- · Avoid rough handling of any kind.
- Avoid bending the system board and hard pushing to prevent cracking at each BGA (Ball Grid Array) chipset.

Important information about replacing RoHS compliant FRUs

RoHS, The Restriction of Hazardous Substances in Electrical and Electronic Equipment Directive (2002/95/EC) is a European Union legal requirement affecting the global electronics industry. RoHS requirements must be implemented on Lenovo products placed on the market after June 2006. Products on the market before June 2006 are not required to have RoHS compliant parts. If the original FRU parts are non-compliant, replacement parts can also be non-compliant. In all cases if the original FRU parts are RoHS compliant, the replacement part must also be RoHS compliant.

Note: RoHS and non-RoHS FRU part numbers with the same fit and function are identified with unique FRU part numbers.

Lenovo plans to transit to RoHS compliance well before the implementation date and expects its suppliers to be ready to support Lenovo's requirements and schedule in the EU. Products sold in 2005 and 2006 will contain some RoHS compliant FRUs. The following statement pertains to these products and any product Lenovo produces containing RoHS compliant FRUs.

RoHS compliant FRUs have unique FRU part numbers. Before or after the RoHS implementation date, failed RoHS compliant parts must always be replaced with RoHS compliant ones, so only the FRUs identified as compliant in the system HMM or direct substitutions for those FRUs may be used.

| Products marketed before June 2006 | | Products marketed after June 2006 | |
|--|-----------------|-----------------------------------|-----------------|
| Current or Replacement original part FRU | | Current or original part | Replacement FRU |
| Non-RoHS | Can be Non-RoHS | | |
| Non-RoHS | Can be RoHS | Must be RoHS | Must be RoHS |
| Non-RoHS | Can sub to RoHS | Must be Koris | Must be Rol15 |
| RoHS | Must be RoHS | | |

Note: A direct substitution is a part with a different FRU part number that is automatically shipped by the distribution center at the time of the order.

General checkout

This chapter presents the following information:

- see "What to do first" on page 20
- see "Power system checkout" on page 21

Before you go to the checkout, make sure to read the following important notes:

Important notes:

- · Only certified trained personnel can service the computer.
- Before replacing any FRU, read the entire page on removing and replacing FRUs.
- . Carefully remove screws for reuse when replacing FRUs.
- Be extremely careful during such write operations as copying, saving, or formatting. Drives in the computer that you are servicing sequence might have been altered. If you select an incorrect drive, data or programs might be overwritten.
- Replace an FRU only with another FRU of the correct model. When you replace an FRU, make sure that the machine model and the FRU part number are correct by referring to the FRU parts list.
- An FRU should not be replaced just because of a single, unreproducible failure. Single failures can occur for a variety of reasons that have nothing to do with a hardware defect, such as cosmic radiation, electrostatic discharge, or software errors. Consider replacing an FRU only when a problem recurs. If you suspect that an FRU is defective, clear the error logs and run the test again. If the error does not recur, do not replace the FRU.
- Be careful not to replace a nondefective FRU.

What to do first

When you do return an FRU, you must include the following information in the parts exchange form or parts return form that you attach to it:

- 1. Name and phone number of servicer
- Date of service
- 3. Date on which the machine failed
- 4. Date of purchase
- 5. Procedure index and page number in which the failing FRU was detected
- 6. Failing FRU name and part number
- 7. Machine type, model number, and serial number
- 8. Customer's name and address

Note for warranty: During the warranty period, the customer may be responsible for repair costs if the computer damage was caused by misuse, accident, modification, unsuitable physical or operating environment, or improper maintenance by the customer.

The following is a list of some common items that are not covered under warranty and some symptoms that might indicate that the system was subjected to stress beyond normal use.

Before checking problems with the computer, determine whether the damage is covered under the warranty by referring to the following list:

The following are not covered under warranty:

- LCD panel cracked from the application of excessive force or from being dropped
- Scratched (cosmetic) parts
- Distortion, deformation, or discoloration of the cosmetic parts
- Plastic parts, latches, pins, or connectors that have been cracked or broken by excessive force
- Damage caused by liquid spilled into the system
- Damage caused by the improper insertion of a PC Card or the installation of an incompatible card
- Improper disk insertion or use of an optical drive
- Diskette drive damage caused by pressure on the diskette drive cover, foreign
 material in the drive, or the insertion of a diskette with multiple labels
- · Damaged or bent diskette eject button
- Fuses blown by attachment of a nonsupported device
- Forgotten computer password (making the computer unusable)
- Sticky keys caused by spilling a liquid onto the keyboard
- · Use of an incorrect AC adapter on laptop products

The following symptoms might indicate damage caused by nonwarranted activities:

- Missing parts might be a symptom of unauthorized service or modification.
- If the spindle of a hard disk drive becomes noisy, it may have been subjected to excessive force, or dropped.

Power system checkout

To verify a symptom, follow the steps below:

- 1. Turn off the computer.
- 2. Remove the battery pack.
- 3. Connect the AC adapter.
- 4. Make sure that power is supplied when you turn on the computer.
- 5. Turn off the computer.
- 6. Disconnect the AC adapter and install the charged battery pack.
- Make sure that the battery pack supplies power when you turn on the computer.

If you suspect a power problem, see the appropriate one of the following power supply checkouts:

- see "Checking the AC adapter" on page 21
- see "Checking operational charging" on page 21
- see "Checking the battery pack" on page 22

Checking the AC adapter

You are here because the computer fails only when the AC adapter is used.

- If the power-on indicator does not turn on, check the power cord of the AC adapter for correct continuity and installation.
- If the computer does not charge during operation, go to "Checking operational charging".

To check the AC adapter, follow the steps below:

- 1. Unplug the AC adapter cable from the computer.
- Measure the output voltage at the plug of the AC adapter cable. See the following figure:



| Pin | Voltage (V DC) |
|-----|----------------|
| 1 | +20 |
| 2 | 0 |
| | |

Note: Output voltage for the AC adapter pin No. 2 may differ from the one you are servicing.

- 3. If the voltage is not correct, replace the AC adapter.
- 4. If the voltage is acceptable, do the following:
- Replace the system board.
- If the problem persists, go to see "Lenovo G700/G710" on page 27.

Note: Noise from the AC adapter does not always indicate a defect.

Checking operational charging

To check whether the battery charges properly during operation, use a discharged battery pack or a battery pack that has less than 50% of the total power remaining when installed in the computer.

Perform operational charging. If the battery status indicator or icon does not light on, remove the battery pack and let it return to room temperature. Reinstall the battery pack. If the charge indicator or icon is still off, replace the battery pack.

If the charge indicator still does not light on, replace the system board. Then reinstall the battery pack. If it is still not charged, go to the next section.

Checking the battery pack

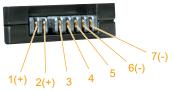
Battery charging does not start until the Power Meter shows that less than 95% of the total power remains; under this condition the battery pack can charge to 100% of its capacity. This protects the battery pack from being overcharged or from having a shortened life.

To check your battery, move your cursor to the Power Meter icon in the icon tray of the Windows[®] taskbar and wait for a moment (but do not click it), and the percentage of battery power remaining is displayed. To get detailed information about the battery, double-click the Power Meter icon.

Note: If the battery pack becomes hot, it may not be able to be charged. Remove it from the computer and leave it at room temperature for a while. After it cools down, reinstall and recharge it.

To check the battery pack, follow the steps below:

- 1. Turn off the computer.
- 2. Remove the battery pack and measure the voltage between battery terminals 1 (+) and 7 (-). See the following figure:



| Terminal | Voltage (V DC) |
|----------|----------------|
| 1 | +0 to +14 |
| 7 | Ground (-) |

- 3. If the voltage is less than +11.0 V DC, the battery pack has been discharged. **Note:** Recharging will be continued for at least 3 hours, even though the indicator does not light on.
 - If the voltage is still less than +11.0 V DC after recharging, replace the battery.
- 4. If the voltage is more than +11.0 V DC, measure the resistance between battery terminals 5 and 7. The resistance must be 4 to 30 K Ω . If the resistance is not correct, replace the battery pack. If the resistance is correct, replace the system board.

Related service information

This chapter presents the following information:

- see "Restoring the factory contents by using Recovery Disc Set" on page 23
- see "Passwords" on page 24
- see "Power management" on page 25

Restoring the factory contents by using Recovery Disc Set

When the hard disk drive or solid state drive is replaced because of a failure, no product recovery program is on the new drive. In this case, you must use the *Recovery Disc Set* for the computer. Order the *Recovery Disc Set* and the drive at the same time so that you can recover the new drive with the pre-installed software when they arrive.

The *Recovery Disc Set* consists of the following set of DVDs to restore the computer to the original factory configuration.

Start Recovery Disc (one disc)

This disc is used to format the hard disk drive and initiate the recovery process.

Operating System Recovery Disc (one or more discs)

This disc restores the Microsoft Windows operating system.

Applications and Drivers Recovery Disc (one or more discs)

This disc restores the pre-installed applications and drivers on the computer.

Supplemental Recovery Disc

This disc contains additional content, such as software for specific models and updates to the software that was preloaded on the computer. Not all recovery disc sets come with a *Supplemental Recovery Disc*.

To restore the computer to the original factory configuration using the recovery disc set, do the following:

- 1. Insert the bootable *Start Recovery Disc* into the optical drive.
- Start the computer. When the Lenovo logo comes up, immediately press F12; on the boot sequence menu, select the optical drive as the first boot-up device. The computer will boot from the Start Recovery Disc. Follow the on-screen instructions to begin the recovery process.
- Read the license. If you agree with the terms, select I accept these terms and conditions and then click Next.
- 4. Insert the **Operating System Recovery Disc** when prompted and click **Yes** to begin the operating system recovery process.
- 5. Insert the *Applications and Drivers Recovery Disc* when prompted and then click **OK** to begin the applications and drivers recovery process.
- If you have a Supplemental Recovery Disc, insert it when prompted and click Yes. If you do not have a Supplemental Recovery Disc, click No.

When all of the data has been copied from the last disc in the set, remove the disc and restart the computer.

Note: The remainder of the recovery process is fully automated and no action is required by you. The computer will restart into the Windows desktop several times and you might experience periods when no activity is apparent on the screen for several minutes at a time. This is normal.

When the recovery process is complete, the Welcome to the Microsoft Windows screen is displayed. Follow the instructions on the screen to complete the Windows setup.

Passwords

As many as three passwords may be needed for any Lenovo computer: the power-on password (POP), the hard disk password (HDP), and the supervisor password (SVP).

If any of these passwords has been set, a prompt for it appears on the screen whenever the computer is turned on. The computer does not start until the password is entered.

Exception: If only an SVP is installed, the password prompt does not appear when the operating system is booted.

Power-on password

A power-on password (POP) protects the system from being powered on by an unauthorized person. The password must be entered before an operating system can be booted.

Hard-disk password

There are two hard-disk passwords (HDPs):

- + User HDP for the user
- + Master HDP for the system administrator, who can use it to get access to the hard disk drive even if the user has changed the user HDP

Attention: If the user HDP has been forgotten, check whether a master HDP has been set. If it has, it can be used for access to the hard disk drive. If no master HDP is available, neither Lenovo nor Lenovo authorized service technicians provide any services to reset either the user or the master HDP, or to recover data from the hard disk drive. The hard disk drive can be replaced for a scheduled fee.

Supervisor password

A supervisor password (SVP) protects the system information stored in the BIOS Setup Utility. The user must enter the SVP in order to get access to the BIOS Setup Utility and change the system configuration.

Attention: If the SVP has been forgotten and cannot be made available to the servicer, there is no service procedure to reset the password. The system board must be replaced for a scheduled fee.

Power management

Note: Power management modes are not supported for APM operating system.

To reduce power consumption, the computer has three power management modes: screen blank, sleep (standby), and hibernation.

Screen blank mode

If the time set on the "Turn off monitor" timer in the operating system expires, the LCD backlight turns off. You can also turn off the LCD backlight by pressing Fn+F2.

To end screen blank mode and resume normal operation, press any key.

Putting your computer to sleep

If you will be away from your computer for only a short time, put the computer to sleep.

When the computer is in sleep mode, you can quickly wake it to resume use, bypassing the startup process.

To put the computer to sleep, do one of the following:

- · Close the display panel.
- Press the power button.
- Open the charms and then select **Settings** \Rightarrow **Power** \bigcirc \rightarrow **Sleep**.

Note: Wait until the power indicator light starts blinking (indicating that the computer is in sleep mode) before you move your computer. Moving your computer while the hard disk is spinning can damage the hard disk, causing loss of data.

To wake the computer, do one of the following:

- Press the power button.
- · Press any key on the keyboard.

Shutting down the computer

If you are not going to use your computer for a long time, shut it down. To shut down your computer:

1. Open the charms, select **Settings** .







2. Select **Power** \bigcirc \rightarrow **Shut down**.





Lenovo G700/G710

This chapter presents the following product-specific service references and product-specific parts information:

- see "Specifications" on page 27
- see "Status indicators" on page 29
- see "Fn key combinations" on page 31
- see "FRU replacement notices" on page 32
- see "Removing and replacing an FRU" on page 33
- see "Locations" on page 65
- see "Parts list" on page 68

Specifications

The following table lists the specifications of the Lenovo G700/G710: *Table 1. Specifications*

| Feature | Description | |
|------------------|---|--|
| Processor | Intel-Chief River Dual Core 35W CPU | |
| Core Chipset | Intel HM70/HM76 | |
| Bus architecture | • FDI | |
| | • DMI 2.0 | |
| | • 1600 MHz DDR3 | |
| | • PCI | |
| | PCI Express bus | |
| Graphic Chipset | • DIS: 17-19W,N14E-GE | |
| | UMA: Intel integrated graphic | |
| Display | • 17.3" HD+, LED backlight, 6.0mm, LVDS | |

Table 1. Specifications (continued)

| Standard memory DDR3L-1 600 SODIMM × 2 Max 16G total CMOS RAM 256 bytes Hard disk drive 320GB, 5400rpm 500GB, 5400rpm 1TB, 5400rpm 1TB, 5400rpm 1TB, 5400rpm 1TB, 5400rpm 1TB, 5400rpm 1TB, Hybrid 500GB, Hybrid Solid-state drive 256GB SSD Optical drive 12.7 mm Rambo/Blueray rambo I/O port Combo audio jack × 1 RJ45 × 1 USB 3.0 × 1, USB 2.0 × 2 2 in 1 slot × 1 (SD/MMC) Kensington lock slot × 1 DC-in × 1 MODEM slot N/A Audio Built-in stereo speakers Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot WLAN WLAN WHAN WHAN Bluetooth wireless Built-in antenna with min-USB interface, select Models Built-in antenna with min-USB interface, select Models | Feature | Description |
|---|-------------------|--|
| Max 16G total CMOS RAM 256 bytes 320GB, 5400rpm 500GB, 5400rpm 750GB, 5400rpm 1TB, 5400rpm 1TB, 4400rpm 1TB, Hybrid 500GB, Hybrid Solid-state drive 256GB SSD Optical drive 12.7 mm Rambo/Blueray rambo I/O port Combo audio jack × 1 RJ45 × 1 USB 3.0 × 1, USB 2.0 × 2 2 in 1 slot × 1 (SD/MMC) Kensington lock slot × 1 DC-in × 1 MODEM slot N/A Built-in stereo speakers Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot SSD × 1 WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN N/A Built-in antenna with min-USB interface, select Models | Standard | • DDR3L-1 600 |
| CMOS RAM • 256 bytes Hard disk drive • 320GB, 5400rpm • 500GB, 5400rpm • 750GB, 5400rpm • 1TB, 5400rpm • 1TB, Hybrid • 500GB, Hybrid • 500GB, Hybrid Solid-state drive • 256GB SSD Optical drive • 12.7 mm • Rambo / Blueray rambo • Combo audio jack × 1 I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 • 1G LAN PCI Express Mini Card slot • Wimax/WIFI × 1 • SSD × 1 • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A | memory | • SODIMM × 2 |
| Hard disk drive * 320GB, 5400rpm * 500GB, 5400rpm * 750GB, 5400rpm * 1TB, 5400rpm * 1TB, Hybrid * 500GB, Hybrid Solid-state drive * 256GB SSD Optical drive * 12.7 mm * Rambo/Blueray rambo I/O port * Combo audio jack × 1 * RJ45 × 1 * USB 3.0 × 1, USB 2.0 × 2 * 2 in 1 slot × 1 (SD/MMC) * Kensington lock slot × 1 * DC-in × 1 MODEM slot * N/A Audio * Built-in stereo speakers * Built-in microphone Video * HDMI × 1 (on select models) * VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot * SSD × 1 WLAN * WLAN 802.11 b/g/n * BT 4.0 combo w/ Wifi module WWAN * Built-in antenna with min-USB interface, select Models * Built-in antenna with min-USB interface, select Models * Built-in antenna with min-USB interface, select Models | | Max 16G total |
| • 500GB, 5400rpm • 750GB, 5400rpm • 1TB, 5400rpm • 1TB, Hybrid • 500GB, Hybrid Solid-state drive • 256GB SSD Optical drive • 12.7 mm • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • Wimax/WIFI × 1 • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • Built-in antenna with min-USB interface, select Models | CMOS RAM | • 256 bytes |
| - 750GB, 5400rpm - 1TB, 5400rpm - 1TB, Hybrid - 500GB, Hybrid Solid-state drive - 256GB SSD Optical drive - Rambo/Blueray rambo I/O port - Combo audio jack × 1 - RJ45 × 1 - USB 3.0 × 1, USB 2.0 × 2 - 2 in 1 slot × 1 (SD/MMC) - Kensington lock slot × 1 - DC-in × 1 MODEM slot - N/A Audio - Built-in stereo speakers - Built-in microphone Video - HDMI × 1 (on select models) - VGA × 1 Ethernet (on the system board) - PCI Express Mini Card slot - WLAN - WLAN 802.11 b/g/n - BT 4.0 combo w/ Wifi module WWAN - Built-in antenna with min-USB interface, select Models - Built-in antenna with min-USB interface, select Models | Hard disk drive | • 320GB, 5400rpm |
| • 1TB, 5400rpm • 1TB, Hybrid • 500GB, Hybrid Solid-state drive • 256GB SSD Optical drive • 12.7 mm • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) • TG LAN PCI Express Mini Card slot • WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • Built-in antenna with min-USB interface, select Models | | • 500GB, 5400rpm |
| • 1TB, Hybrid • 500GB, Hybrid Solid-state drive • 256GB SSD Optical drive • 12.7 mm • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) • TG LAN PCI Express Mini Card slot • Wimax/WIFI × 1 • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • Built-in antenna with min-USB interface, select Models | | • 750GB, 5400rpm |
| • 500GB, Hybrid Solid-state drive • 256GB SSD Optical drive • 12.7 mm • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) • TG LAN PCI Express Mini Card slot • WIMAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • Built-in antenna with min-USB interface, select Models | | • 1TB, 5400rpm |
| Solid-state drive Optical drive • 12.7 mm • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • WIMAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • Built-in antenna with min-USB interface, select Models | | • 1TB, Hybrid |
| Optical drive • 12.7 mm • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | | • 500GB, Hybrid |
| • Rambo/Blueray rambo I/O port • Combo audio jack × 1 • RJ45 × 1 • USB 3.0 × 1, USB 2.0 × 2 • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | Solid-state drive | • 256GB SSD |
| I/O port Combo audio jack × 1 RJ45 × 1 USB 3.0 × 1, USB 2.0 × 2 2 in 1 slot × 1 (SD/MMC) Kensington lock slot × 1 DC-in × 1 MODEM slot N/A Audio Built-in stereo speakers Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot WLAN WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN Bluetooth Built-in antenna with min-USB interface, select Models | Optical drive | • 12.7 mm |
| RJ45 × 1 USB 3.0 × 1, USB 2.0 × 2 2 in 1 slot × 1 (SD/MMC) Kensington lock slot × 1 DC-in × 1 MODEM slot N/A Audio Built-in stereo speakers Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot WIMAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN Bluetooth Built-in antenna with min-USB interface, select Models | | Rambo/Blueray rambo |
| USB 3.0 × 1, USB 2.0 × 2 2 in 1 slot × 1 (SD/MMC) Kensington lock slot × 1 DC-in × 1 MODEM slot N/A Built-in stereo speakers Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN N/A Bluetooth Built-in antenna with min-USB interface, select Models | I/O port | • Combo audio jack × 1 |
| • 2 in 1 slot × 1 (SD/MMC) • Kensington lock slot × 1 • DC-in × 1 MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • Wimax/WIFI × 1 • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | | • RJ45 × 1 |
| Kensington lock slot × 1 DC-in × 1 MODEM slot N/A Audio Built-in stereo speakers Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN Bluetooth Ruilt-in antenna with min-USB interface, select Models Built-in antenna with min-USB interface, select Models | | • USB 3.0 × 1, USB 2.0 × 2 |
| | | • 2 in 1 slot × 1 (SD/MMC) |
| MODEM slot • N/A Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • Wimax/WIFI × 1 • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | | |
| Audio • Built-in stereo speakers • Built-in microphone Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot • Wimax/WIFI × 1 • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | | • DC-in × 1 |
| Built-in microphone Video HDMI × 1 (on select models) VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot SSD × 1 WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN N/A Bluetooth Built-in antenna with min-USB interface, select Models | MODEM slot | • N/A |
| Video • HDMI × 1 (on select models) • VGA × 1 Ethernet (on the system board) • 1G LAN • 1G LAN • Wimax/WIFI × 1 • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | Audio | Built-in stereo speakers |
| VGA × 1 Ethernet (on the system board) PCI Express Mini Card slot WLAN WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN N/A Bluetooth Built-in antenna with min-USB interface, select Models | | Built-in microphone |
| Ethernet (on the system board) PCI Express Mini Card slot WLAN WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN N/A Bluetooth Built-in antenna with min-USB interface, select Models | Video | • HDMI × 1 (on select models) |
| system board) PCI Express Mini Card slot WLAN WLAN WLAN 802.11 b/g/n BT 4.0 combo w/ Wifi module WWAN N/A Bluetooth Built-in antenna with min-USB interface, select Models | | • VGA × 1 |
| Card slot • SSD × 1 WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module • WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | | • 1G LAN |
| WLAN • WLAN 802.11 b/g/n • BT 4.0 combo w/ Wifi module WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | PCI Express Mini | • Wimax/WIFI × 1 |
| BT 4.0 combo w/ Wifi module WWAN N/A Bluetooth Built-in antenna with min-USB interface, select Models | Card slot | • SSD × 1 |
| WWAN • N/A Bluetooth • Built-in antenna with min-USB interface, select Models | WLAN | • WLAN 802.11 b/g/n |
| Bluetooth • Built-in antenna with min-USB interface, select Models | | BT 4.0 combo w/ Wifi module |
| Built-in antenna with min-USB interface, select Models. | WWAN | • N/A |
| | | Built-in antenna with min-USB interface, select Models |
| Keyboard • 6 rows Lenovo Chiclet Keyboard | Keyboard | 6 rows Lenovo Chiclet Keyboard |
| Touch pad • Multi-Touch | Touch pad | - |
| Integrated camera • HD (720p)/0.3 M | Integrated | • HD (720p)/0.3 M |
| Battery • 6 cell, 2200 mAh | Battery | • 6 cell, 2200 mAh |
| AC adapter • 65 W / 90 W | | • |
| Pre-installed • Win8 | | • |
| operating system | operating system | |

Status indicators

The system status indicators below show the computer status:



Table 2. Status indicators

| Indicator | Meaning | | | |
|-------------|-----------------|--|--|--|
| 1 Power on | White: | System is enabled. | | |
| _ (J) | Blinkin | Blinking white: | | |
| | | System is in sleep mode. | | |
| | off: | System is in hibernate mode or shut down. | | |
| 2 Battery | Blinkin | g amber: (500ms off/1s on) | | |
| status | | The remaining power of the battery is less than 5% of its capacity. | | |
| | Blinkin | g amber: (100ms off/3.2s on) | | |
| | | The battery is being charged with the remaining power between 5% and 20% of its capacity. | | |
| | Amber | The computer is operating on battery power with the remaining power between 5% and 20% of its capacity. | | |
| | Blinking white: | | | |
| | White: | The battery is being charged with the remaining power between 20% and 80% of its capacity. The remaining power of the battery is more than 80% of its capacity, or the computer is operating on | | |
| | | battery power with the remaining power between 20% and 80% of its capacity. | | |
| 3 Caps lock | White: | Caps Lock mode is enabled. You can enter all alphabetic characters (A-Z) in uppercase without pressing the Shift key. To enable or disable Caps Lock mode, press the CapsLk key. | | |

Fn key combinations

The following table shows the function of each combination of $\mbox{\sc Fn}$ with a function key.

Table 3. Fn key combinations

| Fn + F1: | Mutes/unmutes the sound. |
|-----------|--|
| Fn + F2: | Decreases the volume level. |
| Fn + F3: | Increases the volume level. |
| Fn + F4: | Closes the currently active window. |
| Fn + F5: | Refreshes the desktop or the currently active window. |
| Fn + F6: | Enables/disables the touch pad. |
| Fn + F7: | Enables/disables Airplane mode. |
| Fn + F8: | Displays all currently active apps. |
| Fn + F9: | Turns on/off the backlight of the LCD screen. |
| Fn + F10: | Toggles the display between the computer and an external device. |
| Fn + F11: | Decreases the display brightness. |
| Fn + F12: | Increases the display brightness. |

FRU replacement notices

This section presents notices related to removing and replacing parts. Read this section carefully before replacing any FRU.

Screw notices

Loose screws can cause a reliability problem. In the Lenovo computer, this problem is addressed with special nylon-coated screws that have the following characteristics:

- They maintain tight connections.
- They do not easily come loose, even with shock or vibration.
- · They are harder to tighten.
- · Each one should be used only once.

Do the following when you service this machine:

- · Keep the screw kit in your tool bag.
- Carefully remove screws for reuse when replacing FRUs.
- Use a torque screwdriver if you have one.

Tighten screws as follows:

· Plastic to plastic

Turn an additional 90° after the screw head touches the surface of the plastic part:



· Logic card to plastic

Turn an additional 180° after the screw head touches the surface of the logic card:



Torque driver

If you have a torque screwdriver, refer to the "Torque" column for each step.

- Make sure that you use the correct screws. If you have a torque screwdriver, tighten all screws firmly to the torque shown in the table. Carefully remove screws for reuse when replacing FRUs. Make sure that all screws are tightened firmly.
- Ensure torque screwdrivers are calibrated correctly following country specifications.

Removing and replacing an FRU

This section presents exploded figures with the instructions to indicate how to remove and replace the FRU. Make sure to observe the following general rules:

- 1. Do not attempt to service any computer unless you have been trained and certified. An untrained person runs the risk of damaging parts.
- 2. Before replacing any FRU, review see "FRU replacement notices" on page 32.
- Begin by removing any FRUs that have to be removed before the failing FRU. Any of such FRUs are listed at the top of the page. Remove them in the order in which they are listed.
- Follow the correct sequence in the steps to remove the FRU, as given in the figures by the numbers in square callouts.
- When turning a screw to replace an FRU, turn it in the direction as given by the arrow in the figure.
- When removing the FRU, move it in the direction as given by the arrow in the figure.
- To put the new FRU in place, reverse the removal procedures and follow any of the notes that pertain to replacement. For information about connecting and arranging internal cables, see "Locations" on page 65.
- 8. When replacing an FRU, use the correct screw as shown in the procedures.

⚠ DANGER

Before removing any FRU, turn off the computer, unplug all power cords from electrical outlets, remove the battery pack, and then disconnect any of the interconnecting cables.

Attention: After replacing an FRU, do not turn on the computer until you have made sure that all screws, springs, and other small parts are in place and none are loose inside the computer. Verify this by shaking the computer gently and listening for rattling sounds. Metallic parts or metal flakes can cause electrical short circuits.

Attention: The system board is sensitive to, and can be damaged by, electrostatic discharge. Before touching it, establish personal grounding by touching a ground point with one hand or using an electrostatic discharge (ESD) strap (P/N 6405959) to remove potential shock reasons.

Note: The illustrations used in this section are of the Lenovo Ideapad Y510p, unless otherwise stated.

1010 Battery pack

⚠ DANGER

Only use the battery specified in the parts list for your computer. Any other battery could ignite or explode.

Figure 1. Removal steps of battery pack

Unlock the manual battery latch 1. Holding the spring-loaded battery latch in the unlocked position 2, remove the battery pack in the direction shown by the arrow 3.



When installing: Install the battery pack along the slide rails of the slot. Then make sure that the battery release lever is in the locked position.

1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover

For access, remove these FRUs in order:

• see "1010 Battery pack" on page 34

Figure 2. Removal steps of HDD/Memory/Mini PCI Express Card slot compartment cover

Remove two screws 1 that secure the compartment cover. Remove the compartment cover in the direction shown by arrow 2.



| S | Step | Screw (quantity) | Color | Torque |
|---|------|-------------------------------------|-------|-----------------|
| | 1 | M2 ×6 mm,flat-head, nylok-coated(2) | Black | 2.0 ~ 2.5 kgfcm |
| | | CPU Door to D | | |

1030 Hard disk drive

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35

Attention:

- Do not drop the hard disk drive or apply any physical shock to it. The hard disk drive is sensitive to physical shock. Improper handling can cause damages and permanent loss of data.
- Before removing the drive, suggest the customer to backup all the information on it if possible.
- Never remove the drive while the system is operating or is in suspend mode.

Figure 3. Removal steps of hard disk drive

Remove the frame fixing screws 1 , pull the HDD bracket in the direction shown by arrow 2 , then take out the hard disk drive secured in a metal frame.



Figure 3. Removal steps of hard disk drive (continued)
Remove four screws 2, then take out the metal frame.



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 1 | M2 × 3 mm, flat-head, nylok-coated (4) | Black | 1.5 ~ 2.0 kgfcm |
| | HDD BKT to D | | |
| 2 | M3 × 3 mm, flat-head, nylok-coated (4) | Black | 1.5 ~ 2.0 kgfcm |
| | HDD BKT to HDD | | |

When installing: Make sure that the HDD connector is attached firmly.

1040 Optical drive

For access, remove this FRU:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35

Figure 4. Removal steps of optical drive



| Step | Screw (quantity) | Color | Torque |
|------|--------------------------------------|-------|-----------------|
| 1 | M2 × 6 mm,flat-head, nylok-coated(1) | Black | 2.0 ~ 2.5 kgfcm |
| | ODD BD to D | | |

1050 **DIMM**

For access, remove these FRUs in order:

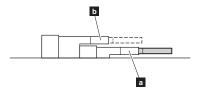
- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35

Figure 5. Removal steps of DIMM

Release the two latches on both edges of the socket at the same time in the direction shown by arrows 1, and then unplug the DIMM in the direction shown by arrow 2.



Note: If only one DIMM is used on the computer you are servicing, the card must be installed in SLOT-0 (a : lower slot), but not in SLOT-1 (b : upper slot).



When installing: Insert the notched end of the DIMM into the socket. Push the DIMM firmly, and pivot it until it snaps into the place. Make sure that it is firmly fixed in the slot and difficult to be moved.

1060 PCI Express Mini Card for wireless LAN/WAN

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35

Figure 6. Removal steps of PCI Express Mini Card for wireless LAN/WAN Disconnect the two wireless LAN cables 1.



In step 1, unplug the jacks by using the removal tool antenna RF connector (P/N: 08K7159), or pick up the connectors with your fingers and gently unplug them in the direction shown by arrows.

Notes: wireless LAN card has 2 cables in step **1**. Wireless LAN card in some models may have 3 cables in step **1**.



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 2 | M2 × 3 mm, flat-head, nylok-coated (1) | Black | 1.5 ~ 2.0 kgfcm |
| | WLAN to C | | |

Figure 6. Removal steps of PCI Express Mini Card for wireless LAN/WAN (continued)

When installing:

- In models with a wireless LAN card that has two antenna connectors, plug the black cable (1st) (MAIN) into the jack labeled **1**, and the white cable (2nd) (AUX) into jack labeled **2** on the card.
- In models with a wireless LAN card that has three antenna connectors, plug the black cable (1st) (MAIN) into the jack labeled 1, the grey cable (3rd) into jack labeled 3, and the white cable (2nd) (AUX) into jack labeled 2 on the card.

1070 Keyboard

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36

Figure 7. Removal steps of keyboard

Remove three screws 1.



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 1 | M2 × 6 mm, flat-head, nylok-coated (3) | Black | 1.5 ~ 2.0 kgfcm |
| | D to KB | | |

Figure 7. Removal steps of keyboard (continued)



Lift the keyboard a little 4, and then detach the connectors in the direction shown by arrows 5. Then remove the keyboard.



1080 Fan assembly and Heat Sink assembly

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42

Figure 8. Removal steps of fan assembly and heat sink assembly

Detach the fan connector in the direction shown by arrow 1. Remove three screws 2 and six screws 3 to lift the fan assembly by arrow 4.



| Step | Screw (quantity) | Color | Torque |
|------|---|-------|-----------------|
| 2 | $M2 \times 6$ mm, flat-head, nylok-coated (3) FAN to C | Black | 1.5 ~ 2.0 kgfcm |
| 3 | M2 × 3 mm, flat-head, nylok-coated (6) CPU BKT & GPU BKT | Black | 1.0 ~ 1.5 kgfcm |



Figure 8. Removal steps of fan assembly and heat sink assembly (continued)

1090 Keyboard bezel

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44

Figure 9. Removal steps of keyboard bezel

Remove twenty screws 1 and one screw 2 on the bottom.



| Step | Screw (quantity) | Color | Torque |
|------|---|-------|-----------------|
| 1 | M2 × 6 mm, flat-head, nylok-coated (20) | Black | 1.5 ~ 2.0 kgfcm |
| | D to C | | |
| 2 | M2 × 2 mm, flat-head, nylok-coated (1) | Black | 1.0 ~ 1.5 kgfcm |
| | D to C | | |

Figure 9. Removal steps of keyboard bezel (continued)

Detach the touchpad button board and power board connectors in the direction shown by arrows 3 and 4 unplug microphone and speakers connectors by arrow 5. Remove three screws 6.



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 6 | M2 × 6 mm, flat-head, nylok-coated (3) | Black | 1.5 ~ 2.0 kgfcm |
| | C bracket to C | | |

When installing: Make sure that all the connectors are attached firmly.

Figure 9. Removal steps of keyboard bezel (continued)
Remove the keyboard bezel in the direction shown by arrow 7.





| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 8 | $M2 \times 2 \text{ mm} + 4.1$, flat-head, nylok-coated (4) | Black | 1.5 ~ 2.0 kgfcm |
| | Speaker to C | | |



Figure 9. Removal steps of keyboard bezel (continued)

Remove the screw 10 to lift the power board and microphone by arrow 11.

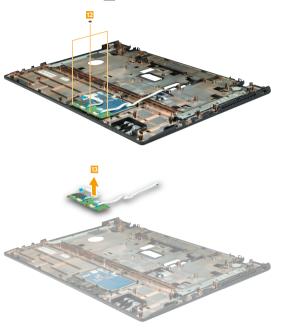


| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 10 | M2 × 3 mm, flat-head, nylok-coated (1) | Black | 1.5 ~ 2.0 kgfcm |
| | Power BD to C | | |



Figure 9. Removal steps of keyboard bezel (continued)

Remove three screws 12, then lift the touchpad board as shown with arrow 13.



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 12 | M2 × 3 mm, flat-head, nylok-coated (3) TP BD to C | Black | 1.5 ~ 2.0 kgfcm |
| | IP BD to C | | |

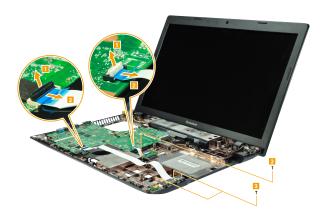
1100 Optical drive board and USB board

For access, remove these FRUs in order:

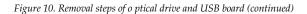
- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46

Figure 10. Removal steps of optical drive and USB board

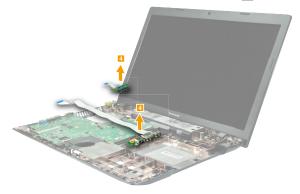
Detach optical drive board and USB board by arrows 1 and 2. Then remove three screws 3.



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 3 | M2 × 6 mm, flat-head, nylok-coated (3) | Black | 1.5 ~ 2.0 kgfcm |
| | ODD BD to D & Audio BD to D | | |



Lift the optical drive board and USB board by arrow 4.



1110 System board

Important notices for handling the system board:

When handling the system board, bear the following in mind.

- Be careful not to drop the system board on a bench top that has a hard surface, such as metal, wood, or composite.
- · Avoid rough handling of any kind.
- In the whole process, make sure not to drop or stack the system board.
- If you put a system board down, make sure to put it only on a padded surface such as an ESD mat or conductive corrugated material.

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46
- see "1100 Optical drive board and USB board" on page 51

Figure 11. Removal steps of system board

Detach DC-IN and LCD screen connector in the direction shown by arrow \P , then remove two screws \P .



| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 2 | M2 × 6 mm, flat-head, nylok-coated (2) | Black | 2.0 ~ 2.5 kgfcm |
| | MB to D | | |

Remove the system board in the direction shown by arrow $\ensuremath{\mathfrak{Z}}$.



1120 CPU

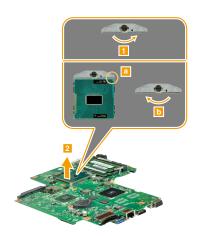
For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46
- see "1110 System board" on page 53

Attention: CPU is extremely sensitive. When you service the CPU, avoid any kind of rough handling.

Figure 12. Removal steps of CPU

Rotate the head of the screw in the direction shown by arrow 1 to release the lock, then remove the CPU in the direction shown by arrow 2.



When installing: Place the CPU on the CPU socket in the direction shown by arrow **a**, and then rotate the head of the screw in the direction shown by arrow **b** to secure the CPU.

Note: Applying labels to the base cover

The new base cover FRU is shipped with a kit containing labels of several kinds. When you replace the base cover, you need to apply the following label:

The following labels need to be peeled off from the old base cover, and need to be put on the new base cover.

a Rating Label

b On line print rating label

C 3G Label

d KCC Label

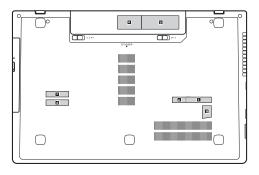
WLAN Label for Israel/Brazil/CA/US/TW/Indonesia/Malaysia

f Indonesia D side label

GML Label

For some models, you also need to apply one or two FCC labels. Check the old base cover; if it has one or two FCC labels, find duplicates of them in the label kit and apply them to the new base cover.

For the location of each label, refer to the following figure:



1130 LCD unit

For access, remove these FRUs in order:

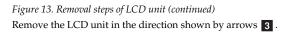
- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46
- see "1100 Optical drive board and USB board" on page 51
- see "1110 System board" on page 53
- see "1120 CPU" on page 55

Figure 13. Removal steps of LCD unit

Release the antenna cables from the cable guides in the direction shown by arrows 1. Remove four screws 2.



| Step | Screw (quantity) | Color | Torque |
|------|---|-------|----------------|
| 2 | M2.5 × 5 mm flat-head, nylok-coated (4) | Black | 1.5 ~2.0 kgfcm |
| | LCD MODULE to D | | |





When installing:

- Route the antenna cables along the cable guides. As you route the cables, make sure that they are not subjected to any tension. Tension could cause the cables to be damaged by the cable guides, or a wire to be broken.
- Make sure that the LCD connector is attached firmly and make sure that you
 do not pinch the antenna cables when you attach the LCD assembly. Route
 the LCD cable along the cable guides.

1140 LCD front bezel

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DÎMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46
- see "1100 Optical drive board and USB board" on page 51
- see "1110 System board" on page 53
- see "1120 CPU" on page 55
- see "1130 LCD unit" on page 57

Figure 14. Removal steps of LCD front bezel

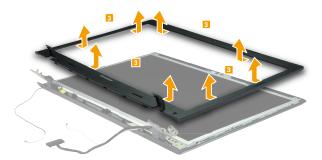
Remove LCD bezel screw pad 1 and two screws 2.



| Step | Screw (quantity) | Color | Torque |
|------|---|-------|-----------------|
| 2 | $M2.5 \times 5$ mm, flat-head, nylok-coated (2) | Black | 1.5 ~ 2.0 kgfcm |
| | B to A | | |



Remove the LCD front bezel in the direction shown by arrows 3.



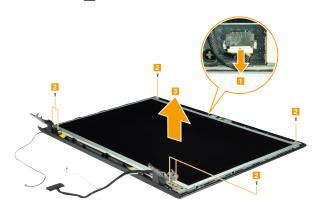
1150 LCD panel, LCD cable, antenna assembly, and hinges

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46
- see "1100 Optical drive board and USB board" on page 51
- see "1110 System board" on page 53
- see "1120 CPU" on page 55
- see "1130 LCD unit" on page 57
- see "1140 LCD front bezel" on page 59

Figure 15. Removal steps of LCD panel, LCD cable, antenna assembly, and hinges

Unplug the integrated camera connector in the direction shown by arrow 1. Remove six screws 2. Lift the LCD panel in the direction shown by arrows 3.



| Step | Screw (quantity) | Color | Torque |
|------|---|-------|-----------------|
| 2 | $M2.5 \times 5$ mm, flat-head, nylok-coated (6) | Black | 1.5 ~ 2.0 kgfcm |
| | Hinge to A | | |

When installing: Make sure that the connector is attached firmly.

Figure 15. Removal steps of LCD panel, LCD cable, antenna assembly, and hinges (continued)

Remove six screws 4 and remove the hinges in the direction shown by arrows 5.



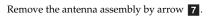
| Step | Screw (quantity) | Color | Torque |
|------|--|-------|-----------------|
| 4 | M2 × 3 mm, flat-head, nylok-coated (6) | Black | 1.0 ~ 1.5 kgfcm |
| | Hinge to Panel | | |

Note: The LCD cables are attached to the LCD panel by a metal connector.

Peel off the adhesive tape and detach the connector in the direction shown by arrow **6**.



Figure 15. Removal steps of LCD panel, LCD cable, antenna assembly, and hinges (continued)





1160 Integrated camera

For access, remove these FRUs in order:

- see "1010 Battery pack" on page 34
- see "1020 Hard disk drive(HDD)/Memory/Mini PCI Express Card slot compartment cover" on page 35
- see "1030 Hard disk drive" on page 36
- see "1040 Optical drive" on page 38
- see "1050 DIMM" on page 39
- see "1060 PCI Express Mini Card for wireless LAN/WAN" on page 40
- see "1070 Keyboard" on page 42
- see "1080 Fan assembly and Heat Sink assembly" on page 44
- see "1090 Keyboard bezel" on page 46
- see "1100 Optical drive board and USB board" on page 51
- see "1110 System board" on page 53
- see "1120 CPU" on page 55
- see "1130 LCD unit" on page 57
- see "1140 LCD front bezel" on page 59
- see "1150 LCD panel, LCD cable, antenna assembly, and hinges" on page 61

Figure 16. Removal steps of integrated camera

Note: The integrated camera is stuck on the top center of the LCD cover.

Remove the integrated camera from the LCD cover 1.



When installing: Stick the integrated camera to the top center of the LCD cover and adjust the placement of it to make sure the connector is attached firmly.

Locations

Front view

- 1 Integrated camera
- 2 Computer display
- 3 Novo button
- 4 Power button
- 5 Speakers
- 6 Built-in microphone(with noise reduction)
- 7 Numeric keypad
- 8 System status indicators
- 9 Touch pad



Right-side view

- 1 Kensington lock slot
- 2 Optical drive (on select models)
- 3 USB port
- 4 Combo audio jack



Bottom and Left-side view

- 1 AC power adapter jack
- 2 Ventilation slots
- 3 VGA port
- 4 HDMI port
- 5 RJ-45 port
- 6 USB port
- 7 Memory card slot
- 8 Battery latch manual
- 9 Battery pack
- 10 Battery latch spring loaded



Parts list

This section presents the following service parts:

- see "Overall" on page 69
- see "LCD FRUs" on page 73
- see "Keyboard" on page 75
- see "Miscellaneous parts" on page 77
- see "AC adapters" on page 78
- see "Screws" on page 79
- see "Power cords" on page 80

Notes

 Each FRU is available for all types or models, unless specific types or models are specified.

Overall

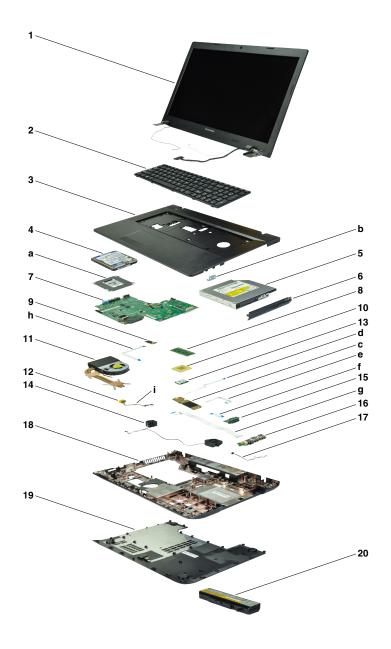


Table 4. Parts list—Overall

| No. | FRU | FRU no. | CRU ID |
|-----|--|----------|--------|
| 1 | LCD unit (see "LCD FRUs" on page 73) | | N |
| 2 | Keyboard (see "Keyboard" on page 75) | | N |
| 3 | BAMBI Upper Case | 90202801 | N |
| 4 | HDD 320G 5400rpm Seagate(Yarra (1D),ST320LT012 7mm 5.4K 320G HDD | 16200212 | ** |
| 4 | HDD 320G 5400rpm HGST(Jaguar B7- RV),HTS545032A7E380 RV 7mm 5.4K 320G HDD | 16200296 | ** |
| 4 | HDD 320G 5400rpm Toshiba(Aquarius-B),MQ01ABF032 7mm 5.4K 320G HDD | 16200274 | ** |
| 4 | HDD 320G 5400rpm Toshiba(Aquarius-B),MQ01ABD032 9.5mm 5.4K 320G HDD | 16200222 | ** |
| 4 | HDD 320G 5400rpm WD(ML320S-AF2),WD3200BPVT 9.5mm 5.4K 320G HDD | 16200022 | ** |
| 4 | HDD 500G 5400rpm Seagate(M8 BP),ST500LM012 9.5mm 5.4K 500G HDD | 16200323 | ** |
| 4 | HDD 500G 5400rpm HGST(Jaguar B7 RV),HTS545050A7E380 RV 7mm 5.4K 500G HDD | 16200297 | ** |
| 4 | HDD 500G 5400rpm Seagate(Yarra (1D)),ST500LT012 7mm 5.4K 500G HDD | 16200211 | ** |
| 4 | HDD 500G 5400rpm Toshiba(Aquarius-B slim),MQ01ABF050 7mm 5.4K 500G HDD | 16200273 | ** |
| 4 | HDD 500G 5400rpm Toshiba(Aquarius-B),MQ01ABD050 9.5mm 5.4K 500G HDD | 16200221 | ** |
| 4 | HDD 500G 5400rpm WD(MN500S),WD5000LPVT- 08G33T1 7mm 5.4K 500G HDD | 16200264 | ** |
| 4 | HDD 750G 5400rpm Seagate(M8 BP),ST750LM022 9.5mm 5.4K 750G HDD | 16200322 | ** |
| 4 | HDD 750G 5400rpm HGST(Jaguar B),HTS541075A9E680 9.5mm 5.4K 750G HDD | 16200192 | ** |
| 4 | HDD 750G 5400rpm Toshiba(Aqurius-B),MQ01ABD075 9.5mm 5.4K HDD | 16200220 | ** |
| 4 | HDD 750G 5400rpm WD(ML375M),WD7500BPVT- 24HXZ 9.5mm 5.4K 750G HDD | 16004848 | ** |
| 4 | HDD 1TB 5400rpm Seagate(M8 BP),ST1000LM024 9.5mm 5.4K 1T HDD | 16200321 | ** |
| 4 | HDD 1TB 5400rpm HGST(Jaguar B),HTS541010A9E680 9.5mm 5.4K 1T HDD | 16200193 | ** |
| 4 | HDD 1TB 5400rpm Toshiba(Aqurius-B),MQ01ABD100 9.5mm 5.4K 1T hDD | 16200219 | ** |
| 4 | HDD 1TB 5400rpm WD(ML500M),WD10JPVT-24A1YT0 9.5mm 5.4K 1T HDD | 16200071 | ** |
| 4 | HDD 1T Hybrid Seagate,ST1000LM014 6G 9.5mm 1T SSHD | 16200389 | ** |
| 4 | HDD 500G Hybrid Seagate,ST500LM000 6G 7mm 500G SSHD | 16200391 | ** |

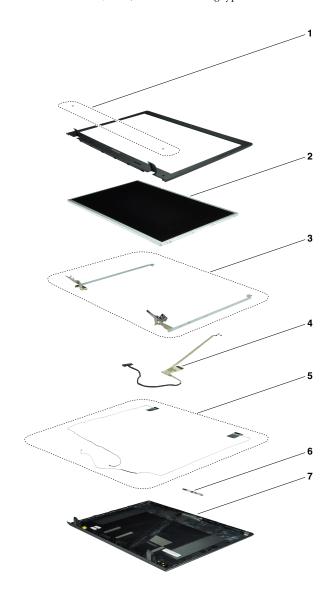
Table 4. Parts list—Overall (continued)

| 5 ODD 12.7 Tray-in Rambo, PLDS DS-8A9SH 12.7 Rambo 25209016 * 5 ODD 12.7 Tray-in Rambo, HLDS GT80N 12.7 Rambo 25209015 * 5 ODD 12.7 Tray-in Rambo, Panasonic UJ8D1 12.7 Rambo 25209017 * 5 ODD 12.7 Tray-in Rambo, PSST SN-208DB 12.7 Rambo 25209014 * 5 ODD 12.7 Tray-in BD Rambo, HLDS BT30N 12.7 BD 25210754 * 8 Rambo ODD 25210757 * 6 BAMBI ODD Bezel 90202781 N 7 BAMBI MB DIS HM76 GE 2G 90003037 N 8 BAMBI MB WSP DIS HM76 GE 2G 90003039 N 9 BAMBI MB WSP DIS HM76 GE 2G 90003039 N 7 BAMBI MB WSP DIS HM76 GE 2G 90003040 N 7 BAMBI MB WSP UMA HM76 90003041 N 8 AMBI MB WSP UMA HM76 90003042 N 9 BAMBI MB WSP UMA HM70 90003138 N 9 BAMBI MB WSP UMA HM70 90003140 N 9 BAMBI MB WSP UMA HM70 900 | No. | FRU | FRU no. | CRU ID |
|--|-----|--|----------|--------|
| ODD ODD 12.7 Tray-in Rambo,Panasonic UJ8D1 12.7 Rambo 25209017 * ODD 12.7 Tray-in Rambo,TSST SN-208DB 12.7 Rambo 25209014 * DDD 12.7 Tray-in BD Rambo,HLDS BT30N 12.7 BD 25210754 * Rambo ODD 25210757 * DDD 12.7 Tray-in BD Rambo,Panasonic UJ260AF 12.7 BD 25210757 * Rambo ODD 25210757 * * BAMBI ODD Bezel 90202781 N * BAMBI MB DIS HM76 GE 2G 90003037 N * BAMBI MB WSP DIS HM76 GE 2G 90003038 N * BAMBI MB WSP DIS HM76 GE 2G 90003039 N * BAMBI MB WSP DIS HM76 GE 2G 90003040 N * BAMBI MB WSP DIS HM76 GE 2G 90003041 N * BAMBI MB WSP UMA HM76 90003042 N * BAMBI MB WSP UMA HM76 90003042 N * BAMBI MB WSS UMA HM70 90003138 N * BAMBI MB WSS UMA HM70 90003129 N * BAMBI MB WSP DIS HM76 GE 1G < | 5 | | 25209016 | * |
| 3 OJD 12.7 Tray-in Rambo, Panasonic UjBJ 12.7 Rambo 25209017 5 ODD 12.7 Tray-in Rambo, TSST SN-208DB 12.7 Rambo 25209014 5 ODD 12.7 Tray-in BD Rambo, HLDS BT30N 12.7 BD 25210754 8 Rambo ODD 25210757 6 BAMBI ODD Bezel 90202781 7 BAMBI MB DIS HM76 GE 2G 90003037 8 BAMBI MB WSP DIS HM76 GE 2G 90003038 7 BAMBI MB WSP DIS HM76 GE 2G 90003039 8 BAMBI MB WSP DIS HM76 GE 2G 90003040 7 BAMBI MB WSP UMA HM76 90003041 8 BAMBI MB WSP UMA HM76 90003041 8 BAMBI MB WSP UMA HM76 90003041 9 BAMBI MB WSP UMA HM70 90003138 9 BAMBI MB WSP UMA HM70 90003139 7 BAMBI MB WSS UMA HM70 90003140 8 BAMBI MB WSS DIS HM76 GE 1G 90003221 7 BAMBI MB WSP DIS HM76 GE 1G 90003221 7 BAMBI MB WSP DIS HM76 GE 1G 90003222 7 BAMBI MB WSP DIS HM70 GE 1G 90003224 7 BAMBI MB WSP DIS HM70 GE 1G 90003225 7 BAMBI MB WSP DIS HM70 GE 2G 90003226 8 RAMI MB WSP DIS HM70 GE 2G 90003227 9 BAMBI M | 5 | , | 25209015 | * |
| ODD ODD 12.7 Tray-in BD Rambo,HLDS BT30N 12.7 BD 25210754 * Rambo ODD CDD 12.7 Tray-in BD Rambo,Panasonic UJ260AF 12.7 BD 25210757 * DDD 12.7 Tray-in BD Rambo,Panasonic UJ260AF 12.7 BD 25210757 * BAMBI ODD Bezel 90003037 N BAMBI MB DIS HM76 GE 2G 90003037 N BAMBI MB W8P DIS HM76 GE 2G 90003038 N BAMBI MB W8D DIS HM76 GE 2G 90003040 N BAMBI MB W8D LMA HM76 90003041 N BAMBI MB W8P UMA HM76 90003042 N BAMBI MB W8P UMA HM70 90003138 N BAMBI MB W8P UMA HM70 90003138 N BAMBI MB W8P UMA HM70 90003139 N BAMBI MB W8P DIS HM76 GE 1G 90003221 N BAMBI MB W8P DIS HM76 GE 1G 90003222 N BAMBI MB W8P DIS HM70 GE 1G 90003224 N BAMBI MB W8P | 5 | ODD | 25209017 | |
| Rambo ODD | 5 | ODD | | |
| Rambo ODD RAMBI ODD Bezel 90202781 N 7 BAMBI MB DIS HM76 GE 2G 90003037 N 7 BAMBI MB WSP DIS HM76 GE 2G 90003038 N 7 BAMBI MB WSP DIS HM76 GE 2G 90003039 N 7 BAMBI MB UMA HM76 90003040 N 7 BAMBI MB WSP UMA HM76 90003041 N 7 BAMBI MB WSP UMA HM76 90003041 N 7 BAMBI MB WSP UMA HM76 90003042 N 7 BAMBI MB WSP UMA HM70 90003138 N 7 BAMBI MB WSP UMA HM70 90003139 N 7 BAMBI MB WSP UMA HM70 90003140 N 8 BAMBI MB WSP UMA HM70 90003140 N 9 BAMBI MB WSP UMA HM70 90003140 N 7 BAMBI MB WSP UMA HM70 90003140 N 8 BAMBI MB WSP DIS HM76 GE 1G 90003221 N 7 BAMBI MB WSP DIS HM70 GE 1G 90003222 N 8 BAMBI MB WSP DIS HM70 GE 2G< | | Rambo ODD | | |
| 7 BAMBI MB DIS HM76 GE 2G 90003037 N 7 BAMBI MB W8P DIS HM76 GE 2G 90003038 N 7 BAMBI MB W8S DIS HM76 GE 2G 90003039 N 7 BAMBI MB UMA HM76 90003040 N 7 BAMBI MB W8P UMA HM76 90003041 N 7 BAMBI MB W8P UMA HM76 90003042 N 7 BAMBI MB WWA HM70 90003138 N 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8S UMA HM70 90003121 N 7 BAMBI MB W8S UMA HM70 90003221 N 7 BAMBI MB W8S UMA HM70 90003221 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003223 N 7 BAMBI MB W8D DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8D DIS HM70 GE 2G 90003225 N 7 BAMBI MB W8D DIS HM70 GE 2G 90003227 N 8 RAM,DDR3L 1600 2 | | Rambo ODD | | |
| 7 BAMBI MB W8P DIS HM76 GE 2G 90003038 N 7 BAMBI MB W8S DIS HM76 GE 2G 90003039 N 7 BAMBI MB UMA HM76 90003040 N 7 BAMBI MB W8P UMA HM76 90003041 N 7 BAMBI MB W8S UMA HM76 90003042 N 7 BAMBI MB UMA HM70 90003138 N 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8S UMA HM70 90003140 N 7 BAMBI MB W8S UMA HM70 90003221 N 7 BAMBI MB W8S DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8D DIS HM70 GE 2G 90003225 N 7 BAMBI MB W8D DIS HM70 GE 2G 90003227 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 | - | | | |
| 7 BAMBI MB W8S DIS HM76 GE 2G 90003039 N 7 BAMBI MB UMA HM76 90003040 N 7 BAMBI MB W8P UMA HM76 90003041 N 7 BAMBI MB W8P UMA HM76 90003042 N 7 BAMBI MB W8S UMA HM70 90003138 N 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8P UMA HM70 90003140 N 7 BAMBI MB W8S UMA HM70 90003121 N 7 BAMBI MB W8S DIS HM76 GE 1G 90003221 N 8 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 9 BAMBI MB W8S DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003224 N 8 BAMBI MB W8P DIS HM70 GE 2G 90003225 N 9 BAMBI MB W8P DIS HM70 GE 2G 90003227 N 9 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 <td></td> <td></td> <td>90003037</td> <td>N</td> | | | 90003037 | N |
| 7 BAMBI MB UMA HM76 90003040 N 7 BAMBI MB W8P UMA HM76 90003041 N 7 BAMBI MB W8S UMA HM76 90003042 N 7 BAMBI MB UMA HM70 90003138 N 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8S UMA HM70 90003140 N 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003223 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003226 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003227 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,K hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * <td></td> <td>BAMBI MB W8P DIS HM76 GE 2G</td> <td>90003038</td> <td>N</td> | | BAMBI MB W8P DIS HM76 GE 2G | 90003038 | N |
| 7 BAMBI MB W8P UMA HM76 90003041 N 7 BAMBI MB W8S UMA HM76 90003042 N 7 BAMBI MB W8S UMA HM70 90003138 N 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8P UMA HM70 90003140 N 7 BAMBI MB W8S UMA HM70 90003221 N 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003227 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425664FR6A-PB 11201299 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200346 * 8 RAM,DDR3L 1600 4GB,SK hynix,HMT451S6AFR8A-PB 11201300 | 7 | BAMBI MB W8S DIS HM76 GE 2G | 90003039 | N |
| 7 BAMBI MB W8S UMA HM76 90003042 N 7 BAMBI MB UMA HM70 90003138 N 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8S UMA HM70 90003140 N 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003223 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003226 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003227 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT42586AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G664HZ-1G601 11200346 * 1600 * 11201300 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11201512 | 7 | BAMBI MB UMA HM76 | 90003040 | N |
| 7 BAMBI MB UMA HM70 90003138 N 7 BAMBI MB WSP UMA HM70 90003139 N 7 BAMBI MB WSS UMA HM70 90003140 N 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB WSP DIS HM76 GE 1G 90003222 N 8 BAMBI MB WSS DIS HM76 GE 1G 90003223 N 9 BAMBI MB DIS HM70 GE 1G 90003224 N 9 BAMBI MB WSP DIS HM70 GE 1G 90003225 N 9 BAMBI MB WSS DIS HM70 GE 1G 90003226 N 9 BAMBI MB WSS DIS HM70 GE 2G 90003227 N 9 BAMBI MB WSS DIS HM70 GE 2G 90003228 N 9 BAMBI MB WSS DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 166M1 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB <t< td=""><td>7</td><td>BAMBI MB W8P UMA HM76</td><td>90003041</td><td>N</td></t<> | 7 | BAMBI MB W8P UMA HM76 | 90003041 | N |
| 7 BAMBI MB W8P UMA HM70 90003139 N 7 BAMBI MB W8S UMA HM70 90003140 N 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8S DIS HM76 GE 1G 90003223 N 7 BAMBI MB DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003226 N 8 BAMBI MB W8P DIS HM70 GE 2G 90003227 N 9 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 9 BAMBI MB W8P DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT42586AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200346 * 1600 * 11200300 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 | 7 | BAMBI MB W8S UMA HM76 | 90003042 | N |
| 7 BAMBI MB W8S UMA HM70 90003140 N 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8S DIS HM76 GE 1G 90003223 N 7 BAMBI MB DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003227 N 8 RAM, DDR3L 1600 2GB, Samsung, M471B5773DH0-YK0 11200502 * 8 RAM, DDR3L 1600 2GB, Samsung, M471B5773DH0-YK0 11201299 * 8 RAM, DDR3L 1600 2GB, Ramaxel, RMT3170ED58F8W-1600 11201835 * 8 RAM, DDR3L 1600 4GB, Samsung, M471B5273DH0-YK 11200346 * 8 RAM, DDR3L 1600 4GB, Samsung, M471B5273DH0-YK 11201503 * 8 RAM, DDR3L 1600 4GB, Sharetronic, SM321NQ08ICF 11201512 * 8 RAM, DDR3L 1600 4GB, Micron, MT8KTF51264HZ-1G6J1 11201342 * | 7 | BAMBI MB UMA HM70 | 90003138 | N |
| 7 BAMBI MB DIS HM76 GE 1G 90003221 N 7 BAMBI MB WSP DIS HM76 GE 1G 90003222 N 7 BAMBI MB WSS DIS HM76 GE 1G 90003223 N 7 BAMBI MB DIS HM70 GE 1G 90003224 N 7 BAMBI MB WSP DIS HM70 GE 1G 90003225 N 7 BAMBI MB WSP DIS HM70 GE 1G 90003226 N 7 BAMBI MB WSP DIS HM70 GE 2G 90003227 N 8 RAM, DDR3L 1600 2GB, Samsung, M471B5773DH0-YK0 11200502 * 8 RAM, DDR3L 1600 2GB, Samsung, M471B5773DH0-YK0 11201299 * 8 RAM, DDR3L 1600 2GB, Samsung, M471B5773DH0-YK0 11201835 * 1600 * 11201835 * 8 RAM, DDR3L 1600 2GB, Micron, MT8KTF25664HZ-1G664HZ-1G601 11200346 * 1600 * 11201300 * 8 RAM, DDR3L 1600 4GB, Samsung, M471B5273DH0-YK 11201512 * 8 RAM, DDR3L 1600 4GB, Sharetronic, SM321NQ08ICF 11201512 * 1600 * | 7 | BAMBI MB W8P UMA HM70 | 90003139 | N |
| 7 BAMBI MB W8P DIS HM76 GE 1G 90003222 N 7 BAMBI MB W8S DIS HM76 GE 1G 90003223 N 7 BAMBI MB DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB DIS HM70 GE 2G 90003227 N 8 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ- 1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200303 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201512 * 1600 * 11201542 * 8 RAM,DDR3L 1 | 7 | BAMBI MB W8S UMA HM70 | 90003140 | N |
| 7 BAMBI MB W8S DIS HM76 GE 1G 90003223 N 7 BAMBI MB DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB DIS HM70 GE 2G 90003227 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 1600 * 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200303 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 < | 7 | BAMBI MB DIS HM76 GE 1G | 90003221 | N |
| 7 BAMBI MB DIS HM70 GE 1G 90003224 N 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB DIS HM70 GE 2G 90003227 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 <t< td=""><td>7</td><td>BAMBI MB W8P DIS HM76 GE 1G</td><td>90003222</td><td>N</td></t<> | 7 | BAMBI MB W8P DIS HM76 GE 1G | 90003222 | N |
| 7 BAMBI MB W8P DIS HM70 GE 1G 90003225 N 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB DIS HM70 GE 2G 90003227 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11 | 7 | BAMBI MB W8S DIS HM76 GE 1G | 90003223 | N |
| 7 BAMBI MB W8S DIS HM70 GE 1G 90003226 N 7 BAMBI MB DIS HM70 GE 2G 90003227 N 7 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 1600 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A- | 7 | BAMBI MB DIS HM70 GE 1G | 90003224 | N |
| 7 BAMBI MB DIS HM70 GE 2G 90003227 N 7 BAMBI MB WSP DIS HM70 GE 2G 90003228 N 7 BAMBI MB WSS DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 1600 * * * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 | 7 | BAMBI MB W8P DIS HM70 GE 1G | 90003225 | N |
| 7 BAMBI MB W8P DIS HM70 GE 2G 90003228 N 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 1600 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 7 | BAMBI MB W8S DIS HM70 GE 1G | 90003226 | N |
| 7 BAMBI MB W8S DIS HM70 GE 2G 90003229 N 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 7 | BAMBI MB DIS HM70 GE 2G | 90003227 | N |
| 8 RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 11200502 * 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 7 | BAMBI MB W8P DIS HM70 GE 2G | 90003228 | N |
| 8 RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB 11201299 * 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 7 | BAMBI MB W8S DIS HM70 GE 2G | 90003229 | N |
| 8 RAM,DDR3L 1600 2GB,Ramaxel,RMT3170ED58F8W-1600 11201835 * 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ-1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,SK hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W-1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | RAM,DDR3L 1600 2GB,Samsung,M471B5773DH0-YK0 | 11200502 | * |
| 8 RAM,DDR3L 1600 2GB,Micron,MT8KTF25664HZ- 1G6M1 11200346 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,SK hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W- 1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | RAM,DDR3L 1600 2GB,SK hynix,HMT425S6AFR6A-PB | 11201299 | * |
| 8 RAM,DDRSL 1600 2GB,Nitcroit,M18x1F23664Ft2- 11200346 1G6M1 11200503 * 8 RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK 11200503 * 8 RAM,DDR3L 1600 4GB,Sk hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W- 11201512 * 1600 * 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | | 11201835 | * |
| 8 RAM,DDR3L 1600 4GB,SK hynix,HMT451S6AFR8A-PB 11201300 * 8 RAM,DDR3L 1600 4GB,SK hynix,HMT451S6AFR8A-PB 11201512 * 1600 * 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | | 11200346 | * |
| 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W- 1600 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | RAM,DDR3L 1600 4GB,Samsung,M471B5273DH0-YK | 11200503 | * |
| 8 RAM,DDR3L 1600 4GB,Ramaxel,RMT3170EB68F9W- 1600 11201512 * 8 RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF 11201834 * 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | RAM,DDR3L 1600 4GB,SK hynix,HMT451S6AFR8A-PB | 11201300 | * |
| 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | | 11201512 | * |
| 8 RAM,DDR3L 1600 4GB,Micron,MT8KTF51264HZ-1G6J1 11201342 * 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | RAM,DDR3L 1600 4GB,Sharetronic,SM321NQ08ICF | 11201834 | * |
| 8 RAM,DDR3L 1600 8GB,Samsung,M471B1G73BH0-YK0 11200504 * 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | 1 1 | 11201342 | * |
| 8 RAM,DDR3L 1600 8GB,SK hynix,HMT41GS6AFR8A-PB 11201301 * | 8 | 1 1 | | * |
| | - | | | * |
| | 8 | | 11201514 | * |

Table 4. Parts list—Overall (continued)

| No. | FRU | FRU no. | CRU ID |
|-----|--|-----------|--------|
| 8 | RAM,DDR3L 1600 8GB,Micron,MT16KTF1G64HZ- | 11201304 | * |
| | 1G6E1 | | |
| 9 | BAMBI Power Board | 90003035 | N |
| 10 | CPU,Intel I7-3632QM 2.2G E1 6M 4cPGA | 102500437 | N |
| 10 | CPU,Intel I7-3612QM 2.1G E1 6M 4cPGA | 102500290 | N |
| 10 | CPU,Intel I7-3520M 2.9G L1 4M 2cPGA | 102500295 | N |
| 10 | CPU,Intel 2020M 2.4G L1 2M 2cPGA | 102500433 | N |
| 10 | CPU,Intel I3-3120M 2.5G L1 3M 2cPGA | 102500435 | N |
| 10 | CPU,Intel I5-3230M 2.6G 3M 2cPGA | 102500486 | N |
| 10 | CPU,Intel I3-3130M 2.6G 3M 2cPGA | 102500487 | N |
| 10 | CPU,Intel 2030M 2.5G 2M 2cPGA | 102500482 | N |
| 10 | CPU,Intel 1000M 1.8G 2M 2cPGA | 102500483 | N |
| 10 | CPU,Intel I3-2348M 2.3G J1 3M 2cPGA | 102500517 | N |
| 10 | CPU,Intel B980 2.4G Q0 2M 2cPGA | 102500362 | N |
| 10 | CPU,Intel B960 2.20G 2M 35W SNB PGA | 102500133 | N |
| 11 | BAMBI Thermal Module DIS W/FAN | 90203067 | N |
| 11 | BAMBI Thermal Module UMA W/FAN | 90203068 | N |
| 12 | DC in Jack 16.2 × 17.0 × 6.5 Drapho PJCS0056-1002H | 73044636 | N |
| 12 | DC in Jack 16.2 × 17.0 × 6.5 Tyco 2129333-1 | 73044637 | N |
| 13 | WLAN,WiFi 1 × 1 BGN,Cbt BCM94313HMG | 20200102 | N |
| | 1 × 1 BGN HMC | | |
| 13 | WLAN,WiFi 1 × 1 BGN,Liteon HB125 1 × 1 BGN HMC | 20200223 | N |
| 13 | WLAN,WiFi 1 × 1 BGN+BT4.0,Cbt BCM943142HM | 20200222 | N |
| | 1 × 1 BGN+BT4.0 HMC | | |
| 13 | WLAN,WiFi 1 × 1 BGN+BT4.0,Liteon WB225 | 20200224 | N |
| | 1 × 1 BGN+BT4.0 HMC | | |
| 14 | speakers | 90202801 | N |
| 15 | BAMBI ODD Board | 90003036 | N |
| 16 | BAMBI USB Board | 90003034 | N |
| 17 | microphone | | N |
| 18 | BAMBI Lower Case | 90202780 | N |
| 19 | BAMBI Lower Case Door | 90202779 | N |
| 20 | Battery,3S2P,6cell,4400mAh,48Wh,Sanyo L11S6Y01 10.8V 48Wh 6cellBTY Comm02 | 121500040 | * |
| 20 | Battery,3S2P,6cell,4400mAh,48Wh,LG L11L6Y01 10.8V 48Wh 6cellBTY Comm02 | 121500042 | * |
| 20 | Battery,3S2P,6cell,4400mAh,48Wh,SMP/S L11M6Y01 10.8V 48Wh 6cellBTY Comm02 | 121500043 | * |
| _ | AC power adapter (see "AC adapters" on page 78). | | |

LCD FRUsIn Lenovo G700/G710, there are following types of LCDs



17.3-in HD TFT

Table 5. Parts list—17.3-in. HD LED

| No. | FRU | FRU no. | CRU ID |
|-----|--|----------|--------|
| 1 | BAMBI LCD Bezel Screw Pad | 90202784 | N |
| 2 | Panel,HD+ -W-G,AUO B173RW01 V5 HD+ G W LED1 NB LCD | 18200208 | N |
| 2 | Panel,HD+ -W-G,CMI N173FGE-L23 HD+ G W LED1 NB LCD | 18200384 | N |
| 2 | Panel,HD+ -W-G,LGD LP173WD1-TLE1 HD+ G W LED1 NB LCD | 18201051 | N |
| 2 | Panel,HD+ -W-G,SEC LTN173KT02-L01 HD+ G W LED1 NB LCD | 18200159 | N |
| 3 | BAMBI Hinge L | 90202785 | N |
| 3 | BAMBI Hinge R | 90202786 | N |
| 4 | BAMBI LCD Cable | 90202794 | N |
| 5 | Antenna | 90202776 | N |
| 6 | BAMBI Camera HD | 90002929 | N |
| 7 | BAMBI LCD Cover | 90202776 | N |

Keyboard

Table 6. Parts list—Keyboard

| Language | | P/N | CRU ID |
|----------|-------------------------|----------|--------|
| | English | 25210891 | |
| | U.K. English | 25210892 | |
| | Italian | 25210893 | |
| | Spanish | 25210894 | |
| | Turkish | 25210895 | |
| | Thai | 25210896 | |
| | Portuguese | 25210897 | |
| | Latin | 25210898 | |
| | Canadian English&French | 25210899 | |
| | Korean | 25210900 | |
| | Traditional Chinese | 25210901 | |
| | Russian | 25210902 | |
| | French | 25210903 | |
| | German | 25210904 | |
| C1-: | Arabic | 25210905 | |
| Chicony | Brazilian | 25210906 | |
| | Japanese | 25210907 | |
| | Dutch | 25210908 | |
| | Greek | 25210909 | |
| | Hebrew | 25210910 | |
| | Hungarian | 25210911 | |
| | Four Nordic countries | 25210912 | N |
| | Belgian | 25210913 | IN |
| | Icelandic | 25210914 | |
| | Slovenian | 25210915 | |
| | Swiss | 25210916 | |
| | International English | 25210917 | |
| | Czechoslovakian | 25210918 | |
| | Bulgarian | 25210919 | |
| | Indian | 25210920 | |
| | U.S. English | 25210921 | |
| | U.K. English | 25210922 | |
| | Italian | 25210923 | |
| | Spanish | 25210924 | |
| | Turkish | 25210925 | |
| | Thai | 25210926 | |
| Sunrex | Portuguese | 25210927 | |
| Sunrex | Latin | 25210928 | |
| | Canadian English&French | 25210929 | |
| | Korean | 25210930 | |
| | Traditional Chinese | 25210931 | |
| | Russian | 25210932 | |
| | French | 25210933 | |
| | German | 25210934 | |

Table 6. Parts list—Keyboard (continued)

| Language | | P/N | CRU IE |
|--------------------|-------------------------|----------|--------|
| | Arabic | 25210935 | |
| | Brazilian | 25210936 | |
| | Dutch | 25210938 | |
| | Greek | 25210939 | |
| | Hebrew | 25210940 | |
| | Hungarian | 25210941 | |
| | Four Nordic countries | 25210942 | |
| Sunrex (continued) | Belgian | 25210943 | |
| (commueu) | Icelandic | 25210944 | |
| | Slovenian | 25210945 | |
| | Swiss | 25210946 | |
| | International English | 25210947 | |
| | Czechoslovakian | 25210948 | |
| | Bulgarian | 25210949 | |
| | Indian | 25210950 | |
| | U.S. English | 25210951 | |
| | U.K. English | 25210952 | |
| | Italian | 25210953 | |
| | Spanish | 25210954 | N |
| | Turkish | 25210955 | |
| | Thai | 25210956 | |
| | Portuguese | 25210957 | |
| | Latin | 25210958 | |
| | Canadian English&French | 25210959 | |
| | Korean | 25210960 | |
| | Traditional Chinese | 25210961 | |
| | Russian | 25210962 | |
| | French | 25210963 | |
| | German | 25210964 | |
| Darfon | Arabic | 25210965 | |
| | Brazilian | 25210966 | |
| | Dutch | 25210968 | |
| | Greek | 25210969 | |
| | Hebrew | 25210970 | |
| | Hungarian | 25210971 | |
| | Four Nordic countries | 25210972 | |
| | Belgian | 25210973 | 1 |
| | Icelandic | 25210974 | |
| | Slovenian | 25210975 | |
| | Swiss | 25210976 | |
| | International English | 25210977 | |
| | Czechoslovakian | 25210978 | |
| | Bulgarian | 25210979 | |
| | Indian | 25210980 | |

Miscellaneous parts

Table 7. Parts list—Miscellaneous parts

| FRU | P/N | CRU ID |
|--|----------|--------|
| System miscellaneous parts: | | |
| (a) BAMBI HDD Bracket | 90202778 | N |
| (b) BAMBI ODD Bracket | 90202774 | |
| • (c) BAMBI TP Board | 90003033 | |
| Cable miscellaneous parts: | | |
| (d) BAMBI TP Button Board Cable | 90202792 | N |
| • (e) BAMBI TP Cable | 90202788 | |
| (f) BAMBI ODD Cable | 90202790 | |
| (g) BAMBI USB Cable | 90202791 | |
| (h) BAMBI Power Board Cable | 90202789 | |
| (i) BAMBI DC-IN cable | 90202793 | |
| Note: Italicized letters in parentheses are references to the | | |
| exploded view in "Overall" on page 69. | | |

AC adapters

Table 8. Parts list—AC adapters

| FRU | P/N | CRU ID |
|--|----------|--------|
| 65W,Delta ADLX65NDC3A 20V3.25A adapter | 36200249 | * |
| 65W,Liteon ADLX65NLC3A 20V3.25A adapter | 36200251 | * |
| 65W,Chicony ADLX65NCC3A 20V3.25A adapter | 36200253 | * |
| 90W,Delta ADLX90NDC3A 20V4.5A adapter | 36200250 | * |
| 90W,Liteon ADLX90NLC3A 20V4.5A adapter | 36200252 | * |
| 90W,Chicony ADLX90NCC3A 20V4.5A adapter | 36200254 | * |

Screws

Table 9. Parts list—Screws

| FRU | P/N | CRU ID |
|--------------------------------------|----------|--------|
| BAMBI Screw M3*3L (K) B-NI | 90202769 | N |
| BAMBI Screw M2.5*5L(K)B-NI,NY | 90202770 | N |
| BAMBI Screw M2*6L(K,D4.6) B-ZN #1 NY | 90202771 | N |
| BAMBI Screw M2*3L (K) B-ZN #1 NY | 90202772 | N |
| BAMBI Screw M2*2L (K) B-ZN #1 NY | 90202773 | N |

Power cords

A Lenovo power cord for a specific country or region is usually available only in that country or region:

Table 10. Parts list—3-pin power cords

| Region | P/N | CRU ID |
|---|-----------|--------|
| China • LINETEK PC323+RVV300/300+LS15 1m | 145000600 | * |
| Argentina • LINETEK LS15+H03VV-F+LP39 1m | 145000599 | * |
| Danmark • LINETEK LS15+H03VV-F+LP-38 1m | 145000598 | * |
| Switzerland • LINETEK LS15+H03VV-F+LP-37 1m | 145000597 | * |
| Brazil • LINETEK LS15 H03VV-F LP26A 1m | 145000596 | * |
| Israel • LINETEK LS15+H03VV-F+LP-41 1m | 145000595 | * |
| UL • LINETEK LP-30B + SPT-2 + LS15 1m | 145000594 | * |
| UK • LINETEK LP-61L+ H03VV-F+ LS15 1m | 145000593 | * |
| Indian • LINETEK PE-361+ H05VV-F+ LS15 1m | 145000592 | * |
| Italy • LINETEK LS15+H03VV-F+PE-336 1m | 145000591 | * |
| Korea • LINETEK LS15+H05VV-F+LP-E04A 1m | 145000590 | * |
| Australia • LINETEK LS15+H03VV-F+LP-23A 1m | 145000589 | * |
| Taiwan • LINETEK LS15+VCTF+LP-53 1m | 145000588 | * |
| Japan • LINETEK LS15+VCTF+LP-54 1m | 145000587 | * |
| Africa • LINETEK LS15+H03VV-F+PE-364 1m | 145000586 | * |
| CE • LINETEK LP-34+H03VV-F + LS15 1m | 145000585 | * |
| China • Longwell LSG-31+RVV300/300+LS-18 1m | 145000568 | * |
| Argentina • Longwell LP-24+H03VV-F+LS-18 1m | 145000567 | * |
| Danmark • Longwell LP-40+H03VV-F+LS-18 1m | 145000566 | * |
| Switzerland • Longwell LP-37+H03VV-F+LS-18 1m | 145000565 | * |
| Brazil • Longwell LP-46+H03VV-F+LS-18 1m | 145000564 | * |
| Israel • Longwell LP-41+H03VV-F+LS-18 1m | 145000563 | * |

Table 10. Parts list—3-pin power cords (continued)

| Region | P/N | CRU ID |
|---|------------------------|--------|
| UL • Longwell LP-30B+SPT-2 18AWG+LS-18 1m | 145000562 | * |
| UK • Longwell LP-61L+H03VV-F+LS-18 1m | 145000561 | * |
| Indian • Longwell LP-67+BIS+LS-18 1m | 145000560 | * |
| Italy • Longwell LP-22+H03VV-F+LS-18 1m | 145000559 | * |
| Korea • Longwell LP-486+KTLH03VV-F+LS-5 1m | 145000558 | * |
| Australia • Longwell LP-23A+LFC-3R+LS-18 1m Taiwan | 145000557 | * |
| Longwell LP-71+VCTF+LS-33 1m Japan | 145000556 | * |
| Longwell LP-54+VCTF+LS-18 1m Africa | 145000555 | * |
| Longwell LP-39+H03VV-F+LS-18 1m CE | 145000554 | * |
| • Longwell LP-34A+H03VV-F+LS-18 1m | 145000553 | * |
| VOLEX GB10S3+RVV 300/500+VAC5S 1m UL | 145000538 | * |
| •VOLEX US15S3+SPT-2 + VAC5S 1m UK | 145000537 | * |
| •VOLEX MP5004+H03VV-F+VAC5S 1m Indian | 145000605 145000536 | * |
| VOLEX IA6A3+IS694+VAC5S 1m Switzerland | 145000536 | * |
| •VOLEX MP232+H03VV-F+VAC5S 1m Italy | 145000524 | * |
| VOLEX IT10S3+HO3VV-F+VAC5S 1m Denmark | 145000533 | * |
| •VOLEX MP233D+H03VV-F+VAC5S 1m Korea | 145000533 | * |
| VOLEX M2511+KETI IEC+VAC5S 1m Australia VOLEX ALMOSO - HOOVIN E-VAC5S 1 | 145000532 | * |
| VOLEX AU10S3+H03VV-F+VAC5S 1m Taiwan VOLEX TW15CS3+VCTF+VAC5S 1m | 145000531 | * |
| Japan •VOLEX VAC5S+VCTF+W755 1m | 145000530 | * |
| Argentina •VOLEX VA2073+H03VV-F+VAC5S 1m | 145000528 | * |
| Brazil •VOLEX CH10S3+H03VV-F+VAC5S 1m | 145000527 | * |
| Israel •VOLEX SI16S3+H03VV-F+VAC5S 1m | 145000526 | * |

Table 10. Parts list—3-pin power cords (continued)

| Region | P/N | CRU ID |
|---|-----------|--------|
| CE •VOLEX M2511+HO3VV-F+VAC5S 1m | 145000525 | * |
| UK •VOLEX 0031+H03VV-F 0.75/3C+0011 1m | 145500000 | * |
| Europe •VOLEX 0033+H03VV-F 0.75/3C+0011 1m | 145500001 | * |
| US •VOLEX 0014+SPT-2 60 °C 18/3C+0016 1m | 145500002 | * |
| China •VOLEX 0036+RVV 300/300 0.75/3C+0002 1m | 145500003 | * |
| Indian •VOLEX 0046+IS694 0.75/3C+0011 1m | 145500004 | * |
| Japan • VOLEX 0018(E)+VCTF 0.75/3C+0021 1m | 145500005 | * |
| Australia •VOLEX 0038+H03VV-F 0.75/3C+0011 1m | 145500006 | * |
| Taiwan •VOLEX 0019+VCTF 0.75/3C+0021 1m | 145500007 | * |
| Korea •VOLEX 0033+H03VV-F 0.75/3C+0011 1m | 145500008 | * |
| Italy •VOLEX 0029+H03VV-F 0.75/3C+0011 1m | 145500009 | * |
| South Africa •VOLEX 0044+H03VV-F 0.75/3C+0011 1m | 145500010 | * |
| Brazil •VOLEX 0034+H03VV-F 0.75/3C+0011 1m | 145500011 | * |
| Israel •VOLEX 0041+H03VV-F 0.75/3C+0011 1m | 145500012 | * |
| Switzerland •VOLEX 0027+H03VV-F 0.75/3C+0011 1m | 145500013 | * |
| Denmark • VOLEX 0048+H03VV-F 0.75/3C+0011 1m | 145500014 | * |
| Argentina • VOLEX 0040+H03VV-F 0.75/3C+0011 1m | 145500015 | * |

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